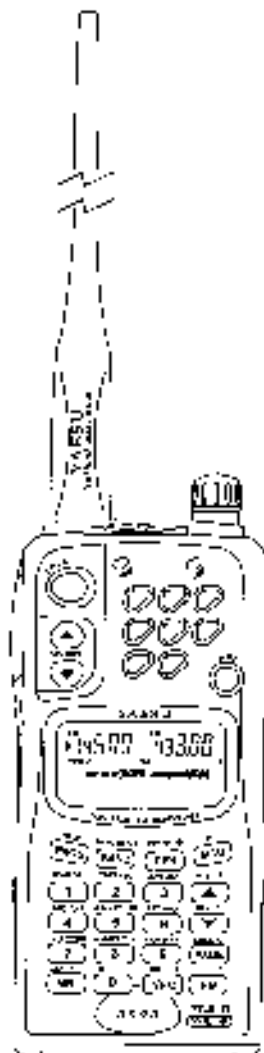


FT-51R

Technical Supplement



YAESU MUSEN CO., LTD.

C.P.O. Box 1500, Tokyo, Japan

YAESU U.S.A.

17210 Edwards Rd., Cerritos, California 90703
U.S.A.

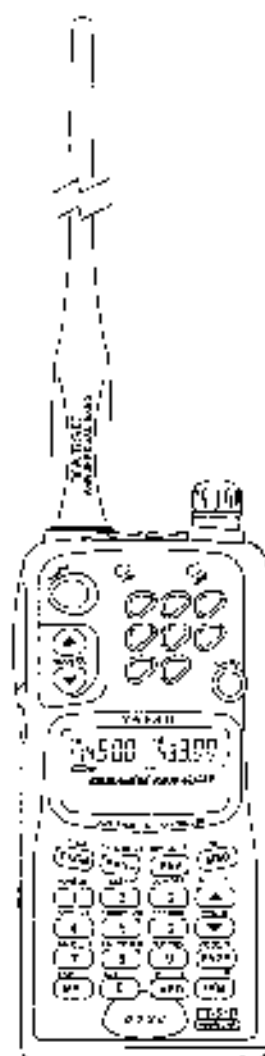
YAESU EUROPE B.V.

Snipweg 3, 1118DN Schiphol, The Netherlands

YAESU UK LTD.

Unit 2, Maple Grove Business Centre

Lawrence Rd., Hounslow, Middlesex TW4 6DR, UK



This manual provides the technical information necessary for servicing the FT-51R Dual-Band hand-held amateur transceiver.

Servicing this equipment requires expertise in handling surface-mount chip components. Attempts by non-qualified persons to service this equipment may result in permanent damage not covered by the warranty, and may be illegal in some countries.

Two PCB layout diagrams are provided for each double-sided board in this transceiver. Each side of the board is referred to by the type of the majority of components installed on that side ("loaded" or "chip-only"). In most cases one side has only chip compo-

nents, and the other has either a mixture of both chip and loaded components (trimmers, coils, electrolytic capacitors, ICs, etc.), or loaded components only.

While we believe the information in this manual to be correct, Yaesu Mosen assumes no liability for damage that may occur as a result of typographical or other errors that may be present. Your cooperation in pointing out any inconsistencies in the technical information would be appreciated.

Yaesu Mosen reserves the right to make changes in this transceiver in the interest of technological improvements, without notification to the owners.

Specifications

General

Frequency range:	(Rx) 110-180 MHz 420-470 MHz (Tx) 144-148 MHz 430-450 MHz
Channel steps:	5, 10, 12.5, 15, 20, 25 & 50 kHz
Repeater shift:	1600 kHz, 15 MHz (programmable)
Emission type:	F3, F2
Supply voltage:	4.0 - 12-V DC
Current Consumption:	VHF UHF
Auto Power Off:	200 μ A 200 μ A
Sbby (Saver on):	16.9 mA 16.3 mA (34 mA dual-rx)
Sbby (Saver off):	52 mA 49 mA (85 mA dual-rx)
Tx (3 W @ 9.6VDC):	<1.6A <1.9A
Antenna (BNC jack):	YITA-53 rubber flexible
Case size (WHD):	57 x 122 x 26.5 mm w/ FNB-31
Weight (approx.):	330 grams with FNB-31 & antenna

Receiver

Circuit type:	Double-conversion superheterodyne
IFs:	43.03 MHz & 455 kHz (VHF) 58.525 MHz & 455 kHz (UHF)
12-dB STNAJD Sensitivity:	< 0.158 μ V (VHF) < 0.180 μ V (UHF)
Adjacent channel selectivity:	> 65 dB VHF > 60 dB UHF
Intermodulation:	> 65 dB (VHF), > 60 dB (UHF)
AF output:	0.2 W @ 8 Ω for 10% THD

Transmitter

RF output:	See the chart at right
Frequency stability:	Better than ± 3 ppm (at -10°C ~ +60°C)
Modulation system:	Variable reactance
Maximum deviation:	± 5 kHz
FM Noise: (@ 1 kHz):	Better than -40 dB @ 1 kHz
Spurious emissions:	> 60 dB below carrier
AF distortion (@ 1 kHz):	< 5%, w/ 3.5 kHz deviation
Microphone type:	2-k Ω condenser

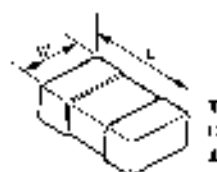
Battery Type	VHF Output	UHF Output
FBA-14 Dry Cell Case (4 x "AA" cells)	2.0 W	1.5 W
FNB-31 (4.8V, 600 mAh)	2.0 W	1.5 W
FNB-33 (4.8V, 1200 mAh)	2.0 W	1.5 W
FNB-35 (7.2V, 800 mAh)	4.0 W	3.5 W
FNB-38 (9.6V, 600 mAh)	5.0 W	5.0 W

Specification subject to change without notice.

Chip Component Information

The diagrams below indicate some of the distinguishing features of common chip components.

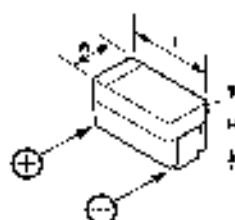
Ceramic Capacitors



(Unit: mm)

Type	L	W	H
2125	2.0	1.25	0.35~0.50
1608	1.6	0.8	0.65~0.85
1005	1.0	0.5	0.45~0.55

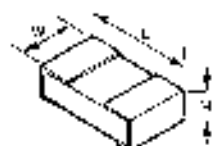
Tantalum Capacitors



(Unit: mm)

Type	L	W	H
P	2.0	1.25	1.2
A	3.2	1.6	1.6
B	3.4	2.8	1.9
C	5.8	3.2	2.3

Resistors



Type: 10MC, 1/10W, 1/16W

Marking: 100, 222, 473 ...

Indicated Letters

1 2 3 4
5 6 7 8
9 0 .

(Unit: mm)

Type	L	W	H
1/10	2.0	1.25	0.5
1/16	1.6	0.8	0.45
1/10S	1.0	0.5	0.35

473		
Ten unit	One unit	Multiplier code
0	0	10^2
1	1	10^1
2	2	10^0
3	3	10^{-1}
4	4	10^{-2}
5	5	10^{-3}
6	6	10^{-4}
7	7	10^{-5}
8	8	10^{-6}
9	9	10^{-7}

Examples:

100—10Ω
222—2.2kΩ
473—47kΩ

Replacing Chip Components

Chip components are installed at the factory by a series of robots. The first one places a spot of adhesive resin at the location where each part is to be installed, and later robots bond and place parts using vacuum suction.

For single-sided boards, solder paste is applied to the board, is then baked to harden the resin and flow the solder. For double-sided boards, no solder paste is applied, but the board is baked (or exposed to UV light) to cure the resin before dip-soldering.

In our laboratories and service shops, small quantities of chip components are mounted manually by applying a spot of resin, placing with tweezers, and then soldering by very small dual streams of hot air (without physical contact during soldering). We remove the parts by first removing solder using a vacuum suction iron, which applies a light, steady vacuum at the iron tip, and then breaking the adhesive with tweezers.

The special vacuum soldering/de-soldering equipment is recommended if you expect to do a lot of chip replacements. Otherwise, it is usually possible to remove and replace chip components with only a tapered, temperature controlled soldering iron, a set of tweezers and braided copper solder wick. Soldering iron temperature should be below 280°C (536°F).

Precautions for Chip Replacement

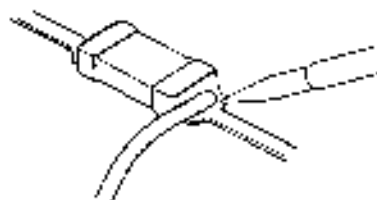
Do not disconnect a chip forcefully, or the foil pattern may peel off the board.

Never re-use a chip component. Dispose of all removed chip components immediately to avoid mixing with new parts.

Limit soldering time to 3 seconds or less to avoid damaging the component and board.

Removing Chip Components

- ① Remove the solder at each joint, one joint at a time, using solder wick wetted with non-acidic flux as shown below. Avoid applying pressure, and do not attempt to remove the binding from the chip's electrode.



- ② Grasp the chip on both sides with tweezers, and gently twist the tweezers back and forth (to break the adhesive bond) while alternately heating each electrode. Be careful to avoid peeling the foil traces from the board. Dispose of the chip when removed.



- ③ After removing the chip, use the copper braid and soldering iron to wick away any excess solder and smooth the lead for installation of the replacement part.

Installing a Replacement Chip

As the value of some chip components is not indicated on the body of the chip, be careful to get the right part for replacement.

- ➊ Apply a small amount of solder to the part on one side where the chip is to be installed. Avoid using too much solder, which may cause bridging (shorting to other Parts).



- ➋ Hold the chip with tweezers in the desired position, and apply the soldering iron with a motion line that is indicated by the arrow in the diagram below. Do not apply heat for more than 3 seconds.



- ➌ Remove the tweezers and solder the electrode on the other side in the manner just described.

Transceiver Disassembly and PCB Access

CNTL Unit Removal

Turn the radio off then remove the battery and soft case, if used.

- Use a deep-ended wrench to remove the lock nut from the DIAL knob (Figure 1). Also remove the small screw located between the EAR and MIC jack on the top panel.

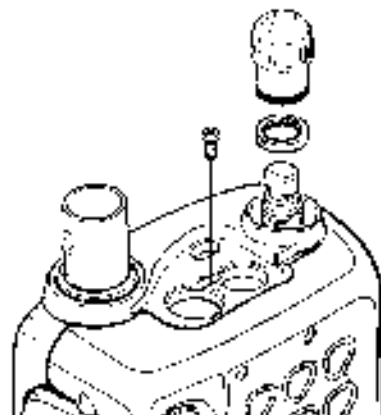


Figure 1.

- Carefully separate the front and rear transceiver halves, set the front half aside for now.
- Remove the three (3) screws as shown below, and separate the CONTACT assembly from the main unit. Be careful not to lose the battery release slide and its small screw.

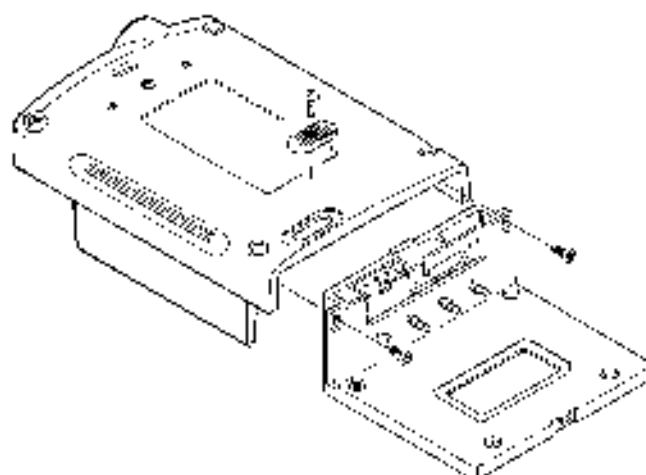


Figure 3.

- Lay the transceiver on a flat surface covered with a soft cloth to protect the front case from marring, and remove the eight (8) rear-panel screws (Figure 2). Be careful not to mix removed screws (some appear similar, but have different types of threading/pitch).

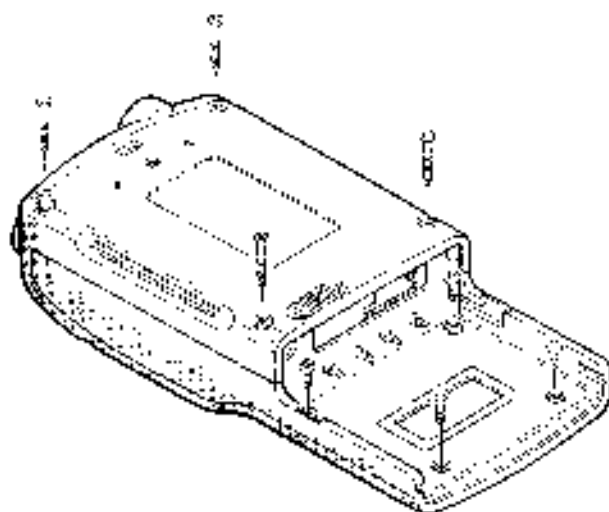


Figure 2.

- Disconnect the flat ribbon cable from its connector on the CNTL Unit by using two fingertips to slide out the cable release, then unplugging the cable from the Mother Unit (Figure 4).

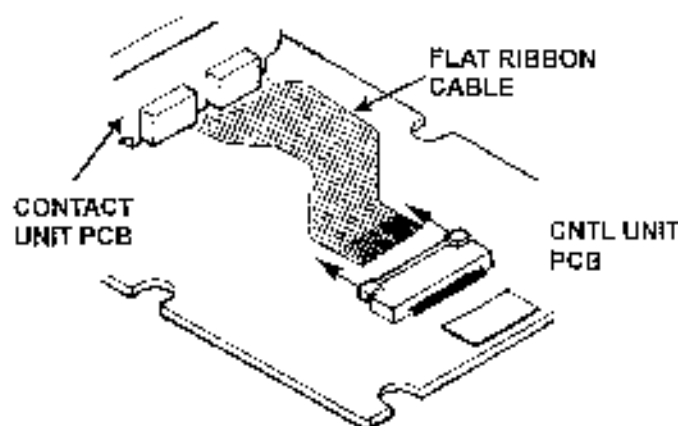


Figure 4.

Transceiver Disassembly and PCB Access

- Next angle the CNTL Unit upward and outward away from the MAIN Unit.

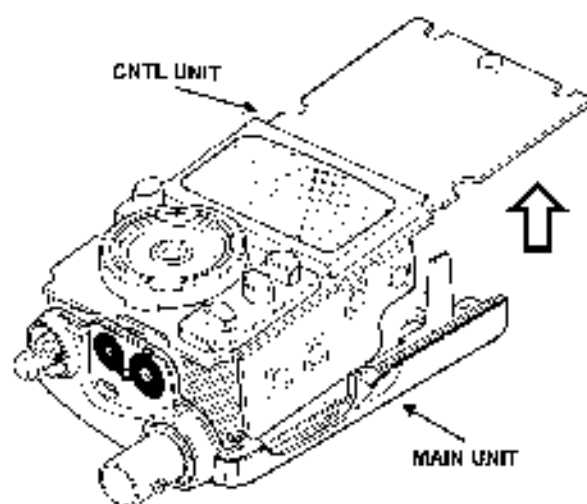


Figure 5.

Contact Unit Removal

- Use a small flat screw driver and slowly pry the two mating connectors and CONTACT Unit PCB free from the 144 and 430 Mother Unit boards, as shown below (Figure 6). Alternately pry between the two points to separate the unit. *Warning!* Use extreme caution during this step, as delicate surface-mounted components are located around the pry-points.

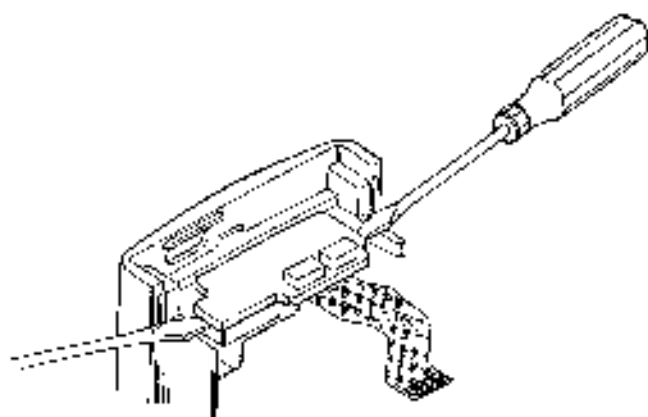


Figure 6.

144-Mother Unit Removal

- Referring to Figure 7, remove the five (5) screws from the 144 Mother Unit, then carefully lift the copper shield plate to expose the 144-Mother Unit assembly.

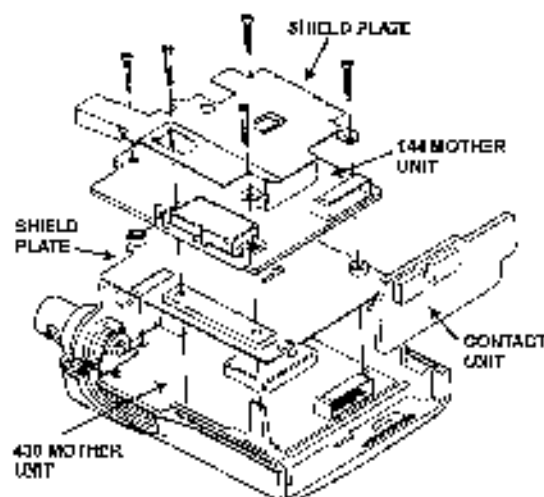


Figure 7.

- Lift the 142-Mother Unit up to free it from inter-board connector J1001.

430 Mother Unit Removal

- With the 144-Mother Unit removed, lift the shield plate to expose the 430-Mother Unit, as shown below (Figure 8).

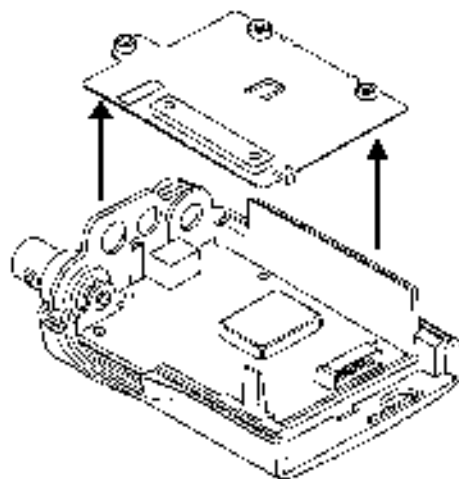


Figure 8.

- Remove the single screw at the upper-left corner of the 430-Mother Unit to remove the BNC antenna jack (see Figure 9 on top of next page).

Transceiver Disassembly and PCB Access

- With the CNTL Unit exposed, note the tab polarity of BT1001.

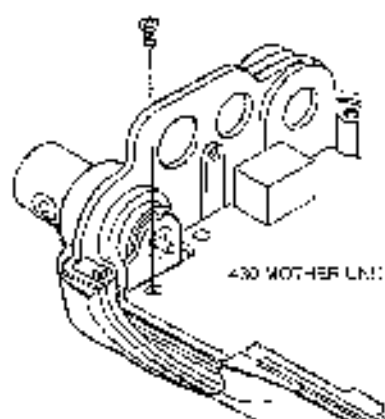


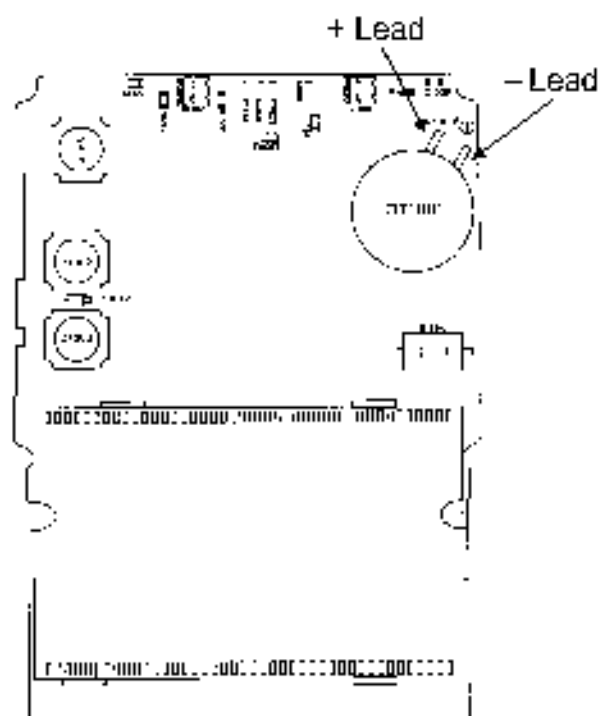
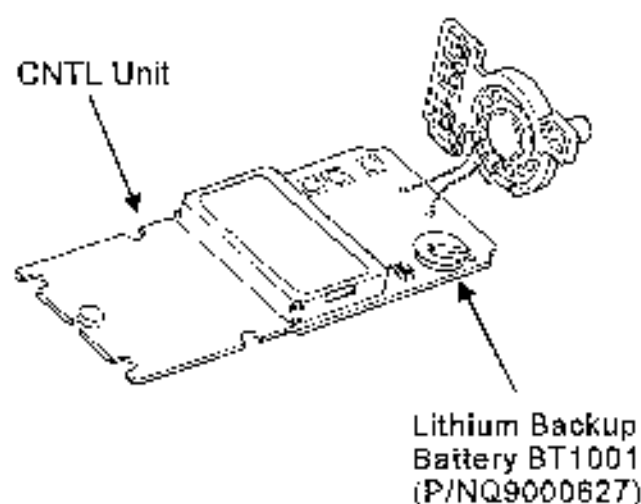
Figure 9.

- This completes the disassembly procedure; reassemble all units in the reverse manner, paying attention to screw type and location. With the CNTL Unit removed, the translucent keyboard membrane, PTT or POWER switch covers can be popped out for replacement if needed.

Be sure to keep the rubber gasket around the CNTL Unit MIC & EAR jack, and to carefully align it with case cut-out when reinstalling the CNTL Unit into the case.

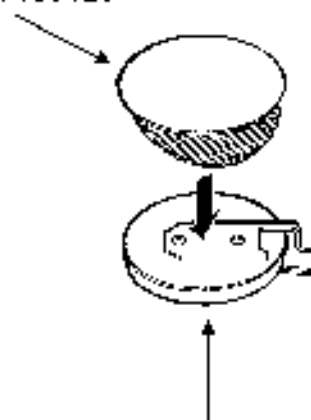
Lithium Backup Battery Replacement

The lithium backup battery does not normally need to be replaced for several years. However, to replace the cell, order Yaesu P/N Q9000627.



- To remove the old cell, carefully unsolder each terminal from the CNTL Unit PCB and lift it free.
- Mount the replacement cell in the similar manner, observing proper polarity when installing it. Next, peel off the adhesive backing from the plastic insulating seal (P/N R7150420), and place the seal on top of the cell.

Insulating Seal
P/N R7150420



Lithium Backup Battery
P/N Q9000627

The FT-51B is carefully aligned at the factory for the specified performance across the amateur band. Realignment should therefore not be necessary except in the event of a component failure. All component replacement and service should be performed only by an authorized Yaesu representative, or the warranty policy may be void.

The following procedures cover the sometimes critical and tedious adjustments that are not normally required once the transceiver has left the factory. However, if damage occurs and some parts subsequently are replaced, realignment may be required. If a sudden problem occurs during normal operation, it is likely due to component failure; realignment should not be done until after the faulty component has been replaced.

We recommend that servicing be performed only by authorized Yaesu service technicians who are experienced with the circuitry and fully equipped for repair and alignment. Therefore, if a fault is suspected, contact the dealer from whom the transceiver was purchased for instructions regarding repair. Authorized Yaesu service technicians realign all circuits and make complete performance checks to ensure compliance with factory specifications after replacing any faulty components.

Those who do undertake any of the following alignments are cautioned to proceed at their own risk. Problems caused by unauthorized attempts at realignment are not covered by the warranty policy. Also, Yaesu reserves the right to change circuits and alignment procedures in the interest of improved performance, without notifying owners.

Under no circumstances should any alignment be attempted unless the normal function and operation of the transceiver are clearly understood, the cause of the malfunction has been clearly pinpointed and any faulty components replaced, and realignment determined to be absolutely necessary.

The following test equipment (and thorough familiarity with its correct use) is necessary for complete realignment. Correction of problems caused by misalignment resulting from use of improper test equipment is not covered under the warranty policy. While most steps do not require all of the equipment listed, the interactions of some adjustments may require that more complex adjustments be performed afterwards. Do not attempt to perform only a single step unless it is clearly isolated electrically from all other steps. Have all test equipment ready before

beginning, and follow all of the steps in a section in the order presented.

Required Test Equipment

- RF Signal Generator with calibrated output level at 500 MHz
- Deviation Meter (linear detector)
- In-line Wattmeter with 5% accuracy at 500 MHz
- 50- Ω RF Dummy Load
- 8- Ω AF Dummy Load
- Regulated DC Power Supply adjustable from 3 to 12 VDC, 2A
- Frequency Counter: 0.2 ppm accuracy at 500 MHz
- AF Signal Generator
- AC Voltmeter
- DC Voltmeter: high impedance
- VHF/UHF Sampling Coupler
- SIGNAL Meter

Alignment Preparation & Precautions

A 50- Ω dummy load and in line wattmeter must be connected to the main antenna jack in all procedures that call for transmission, except where specified otherwise. Correct alignment is not possible with an antenna.

After completing one step, read the following step to determine whether the same test equipment will be required. If not, remove the test equipment (except dummy load and wattmeter, if connected) before proceeding.

Correct alignment requires that the ambient temperature be the same as that of the transceiver and test equipment, and that this temperature be held constant between 20° and 30°C (68° - 86°F). When the transceiver is brought into the shop from hot or cold air, it should be allowed some time to come to room temperature before alignment.

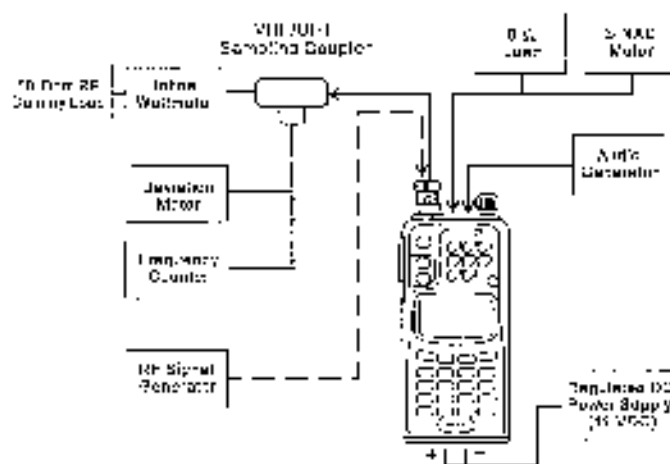
Whenever possible, alignments should be made with oscillator shields and circuit boards firmly affixed in place. Also, the test equipment must be thoroughly warmed up before beginning.

Note: Signal levels in dB referred to in the alignment procedure are based on 0 dBm = 0.5 μ V.

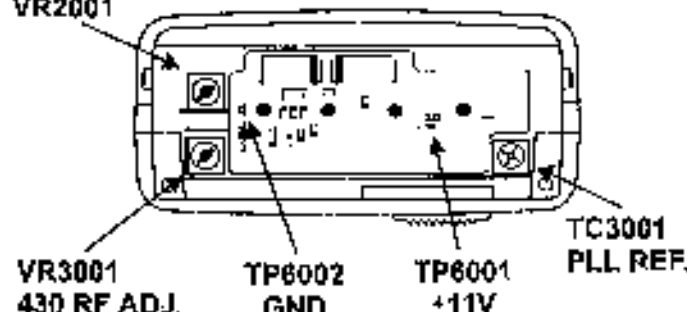
Alignment

Alignment Power Connections

The FT-51R must be partially disassembled to perform the following three steps. The contact assembly must be removed to allow access to the adjustment points, and power must be applied using miniature hook-on clips. The graphics below show the test-point locations and how to connect the hook-on clips. Refer to the *PCB Access & Disassembly* chapter for proper disassembly instructions, and ensure you have the proper hook-on clips before beginning.



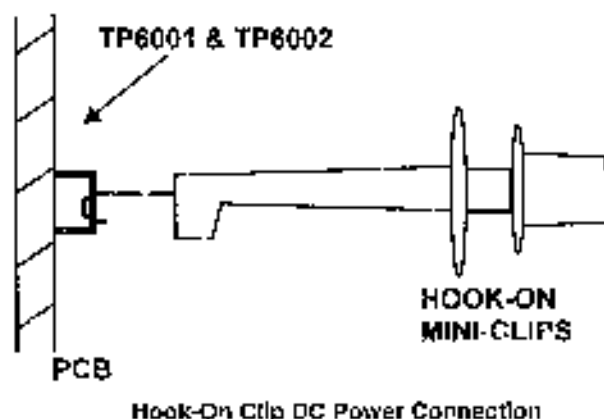
144 RF ADJ.
VR2001



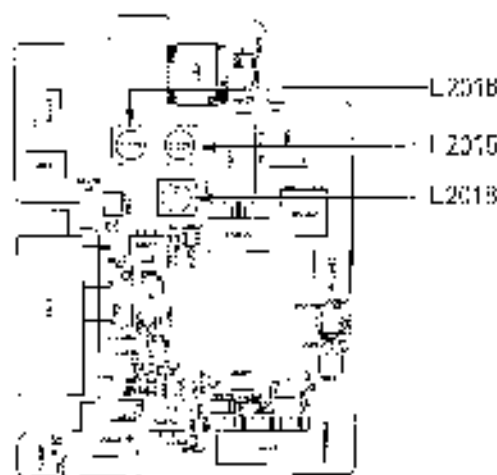
Alignment Points & Power Connection

PLL & Transmitter

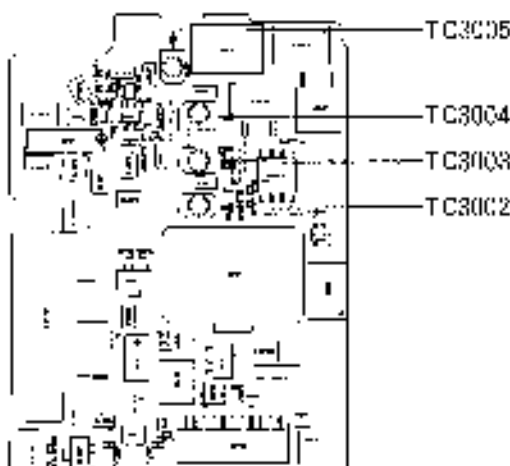
Set up the test equipment as shown for transceiver alignment. With the battery contact assembly removed, apply 11 VDC power to the transceiver using miniature hook-on clips applied to the points on the Contact Unit PCB as shown below.



Refer to the drawings below for VHF and UHF Alignment Points.



144-Mother Unit Alignment Points



430-Mother Unit Alignment Points

PLL Reference Frequency

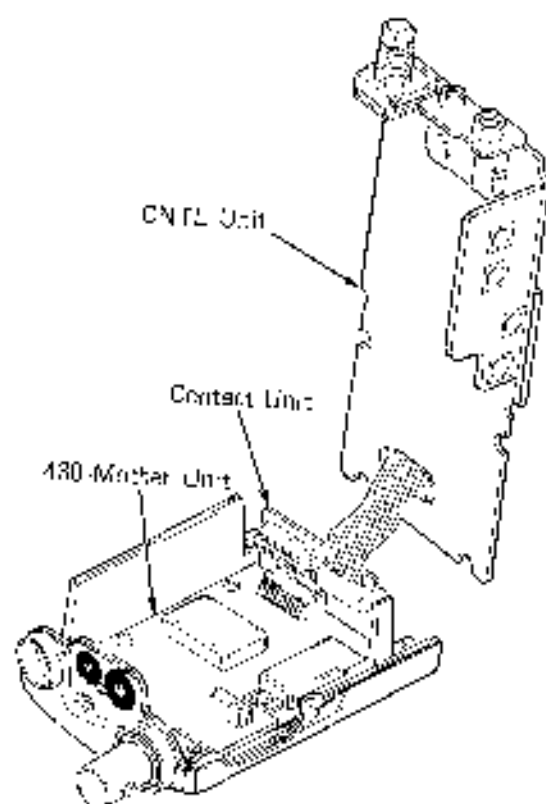
- With the wattmeter, dummy load and frequency counter connected to the antenna jack, and while tuned to the center of the UHF band, key the transmitter and adjust **TC3001** on the 430-Mother Unit, if necessary, so the counter frequency is within 100 Hz of the displayed frequency on the FT-51R.

Transmitter Power Adjustment

- ▮ Connect the 50-Ω dummy load and inline wattmeter to the antenna jack. Tune to the UHF band center and select high power output. Key the transmitter and adjust **VR3001** on the 430-Mother Unit for $5\text{ W} \pm 0.2\text{ W}$ on the meter.
- Tune to VHF band center and select high power output. Key the transmitter and adjust **VR2001** on the 144-Mother Unit for $5\text{ W} \pm 0.2\text{ W}$ on the meter.

144-Mother Unit Interstage Transformer Alignment

- Connect the RF signal generator to the antenna jack, and connect the 8-Ω dummy load and SINAD meter to the EAR jack.
- Tune the transceiver and the RF signal generator to the band center, and inject a signal modulated with $\pm 3.5\text{ kHz}$ deviation of a 1-kHz tone.
- ▮ Adjust **L2015**, **L2016** and **L2018** on the 144-Mother Unit for optimum 12 dB SINAD (at least -9 dB for 12 dB SINAD).



430-Mother Unit Interstage Transformer Alignment

Important! Before proceeding, ensure the 430-Mother Unit is grounded to the transceiver rear case by reinstalling the five previously removed screws.

- Unplug the CONTACT Unit from the 144- & 430-Mother Unit assembly. Next, remove the 5 screws from the shield case on the 144-Mother Unit, and remove the shield case.
- ▮ Remove the 144-Mother Unit to expose the 430-Mother Unit. Plug the CONTACT Unit into the 430-Mother Unit. Connect the RF signal generator to the antenna jack, and 8-Ω dummy load and SINAD meter to the EAR jack.
- Tune the transceiver and the RF signal generator to the band center and inject a signal modulated with $\pm 3.5\text{ kHz}$ deviation of a 1-kHz tone.
- ▮ Adjust **TC3002-TC3005** for optimum 12 dB SINAD (at least -8 dB for 12 dB SINAD). This completes the first part of the alignment; re-assemble the transceiver and proceed to the Internal System Alignment Routine.

Internal System Alignment Routine

The remainder of the alignment uses a routine programmed in the transceiver. This routine simplifies many previously complex discrete component settings and adjustments with digitally controlled settings via front panel buttons and LCD indications.

Transceiver adjustments include:

- Band & IT Selection (non-adjustable)
- S-Meter Full Scale & S-1 Adjustment
- Squelch Threshold & Tight Adjustment
- Modulation (Low & High) Adjust

- To begin, set the transceiver to the VHF and UHF band center, then turn the transceiver off. Next, press and hold **[VHF]** and **[UHF]** together while powering the radio again. The display now shows the first setting. Note that the first two settings are not adjustable and are left as set from the factory.

In the alignment, each adjustment is selected by rotating the DIAL knob. Alignment is performed by holding the **[ENTR]** key for $\frac{1}{2}$ second (**[ENTR]** blinks), then injecting a signal of the required frequency and level.

Pressing **[ENTR]** after a level setting or adjustment is made stores the entry. To exit the alignment routine, press **[EXIT]**. After performing the system alignment in its entirety, individual settings can be returned to and adjusted should the need arise.

Alignment

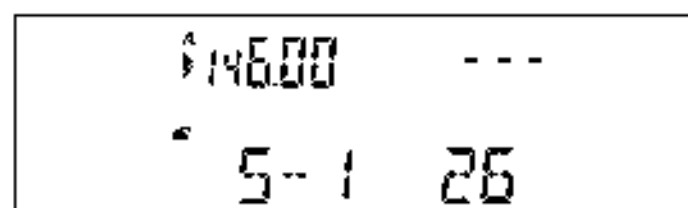
VHF Alignment

S Meter Full-Scale Adjust(VHF)



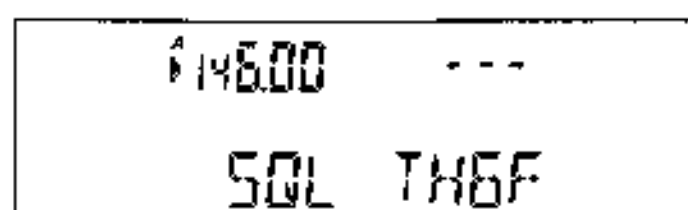
- If you haven't done so already, perform the power-on key combination previously described then press **[MEM] → [VHF]** so that the right display blanks. Next hold **[MEM]** for ½ second (**[F]** blinks), at the beginning of each selection.
- Inject a +20dBμ RF signal (13.5kHz deviation @ 1-kHz) to the antenna input, press **[MEM]** to save the setting (**[F]** turns off), then rotate the DIAL knob for the next setting.

Low Scale S 1 Adjustment(VHF)



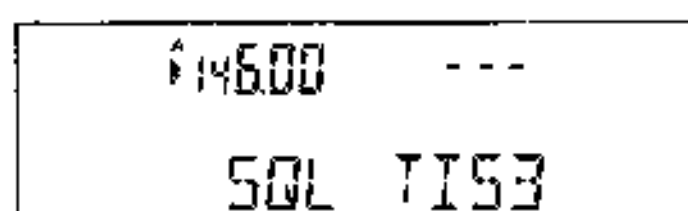
- Adjust the generator level to -5dBμ, press **[MEM]** and rotate the DIAL for the next setting.

Squelch Preset Threshold(VHF)



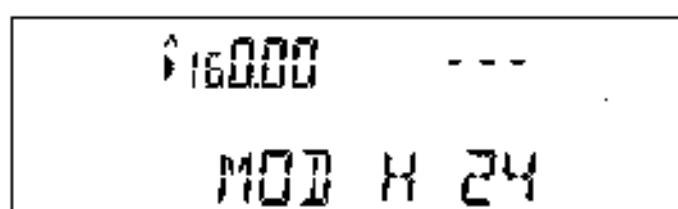
- Adjust the generator level for a -11dBμ signal, press **[MEM]** and rotate the DIAL for the next setting.

Squelch Preset Tgt(VHF)



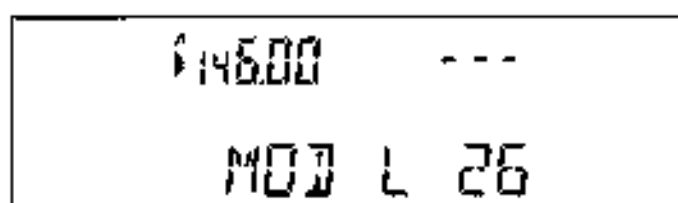
- Adjust the generator level for a -5dBμ signal, then press **[MEM]** and rotate the DIAL for the next setting.

Vx Deviation (VHF) (for A3, B3 & C3 Versions only)



- While tuned to 160.000 MHz, adjust the AF generator level for 25 mV_{rms} @1 kHz to the **MIC** jack.
- Hold **[MEM]** for ½ second, then key the tx and press **[F3]/[F4]** to obtain ±4.2 ~ 4.5 kHz on the deviation meter (±3.7 ~ 4.0 kHz for A3 version). Press **[MEM]** and rotate the DIAL knob for the next setting.

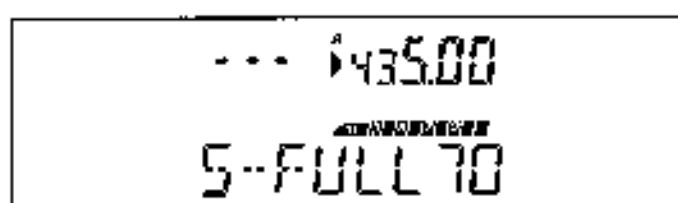
Vx Deviation (VHF)



- Tune to 146.000 MHz and adjust the AF generator for 25 mV_{rms} output @ 1 kHz to the **MIC** jack. Key the transmitter and press **[F3]/[F4]** to obtain ±4.2 ~ 4.5 kHz indicated on the deviation meter (±3.7 ~ 4.0 kHz for A1, A2 & A3 versions). Press **[MEM]** and rotate the DIAL knob for the next setting.

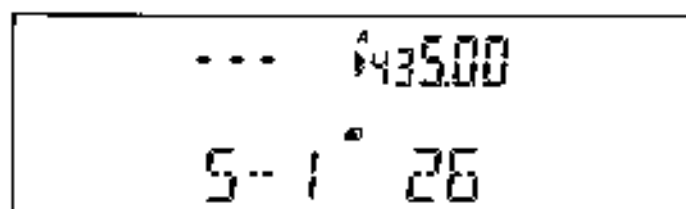
UHF Alignment

S-Meter Full Scale Adjust(UHF)



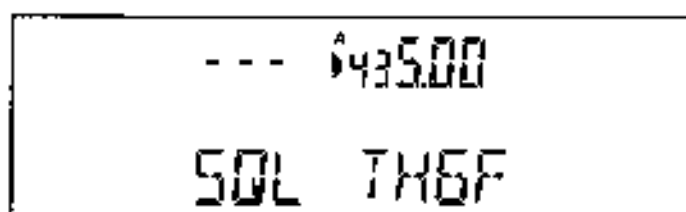
- Press **[MEM] → [UHF]** so that the left display blanks. Remember to hold **[MEM]** for ½ second (**[F]** blinks), at the beginning of each selection.
- Inject a +20dBμ RF signal (±3.5kHz deviation @ 1-kHz), press **[MEM]** to save the entry (**[F]** stops blinking), then rotate the DIAL knob for the next setting.

Low-Scale S-1 Adjustment(UHF)



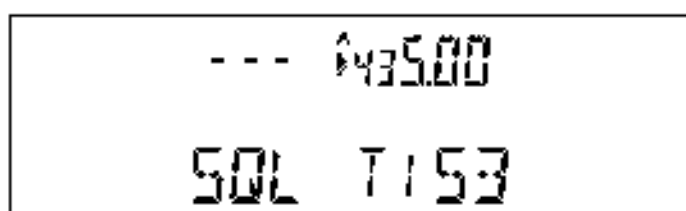
- Adjust the RF signal generator level for -5dBμ, press **[AM]** and rotate the DIAL for the next setting.

Squelch Preset Threshold(UHF)



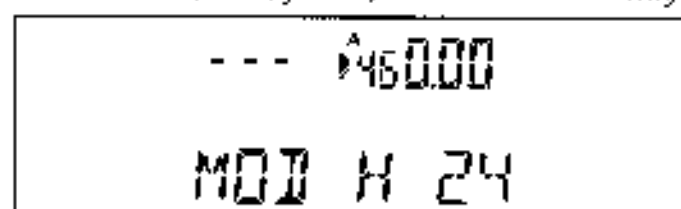
- Adjust the RF signal generator level for -11dBμ, press **[UM]** and rotate the DIAL for the next setting.

Squelch Preset Tght(UHF)



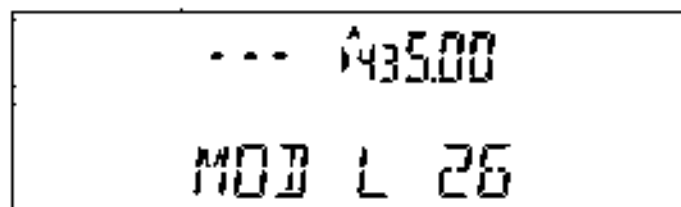
- Adjust the RF signal generator level for -5dBμ, then press **[BM]** and rotate the DIAL for the next setting.

Tx Deviation (UHF) for A3, B3 & C3 Versions only



- While tuned to 460.000 MHz, adjust the AF generator for 25 mV_{rms} output @ 1 kHz to the **MIC** jack.
- Hold **[UM]** for $\frac{1}{2}$ second, then key the transmitter and press **[▲]/[▼]** to obtain $\pm 4.2 \sim 4.5$ kHz indicated on the deviation meter ($\pm 3.7 \sim 4.0$ kHz for A3 version). Press **[BM]** and rotate the DIAL knob for the next setting.

Tx Deviation Adjustment UHF



- Return to the UHF band center, then adjust the AF generator attenuator level for 25 mV_{rms} @ 1 kHz to the **MIC** jack. Key the transmitter and press **[▲]/[▼]** to obtain $\pm 4.2 \sim 4.5$ kHz indicated on the deviation meter ($\pm 3.7 \sim 4.0$ kHz for A1, A2 & A3 versions).

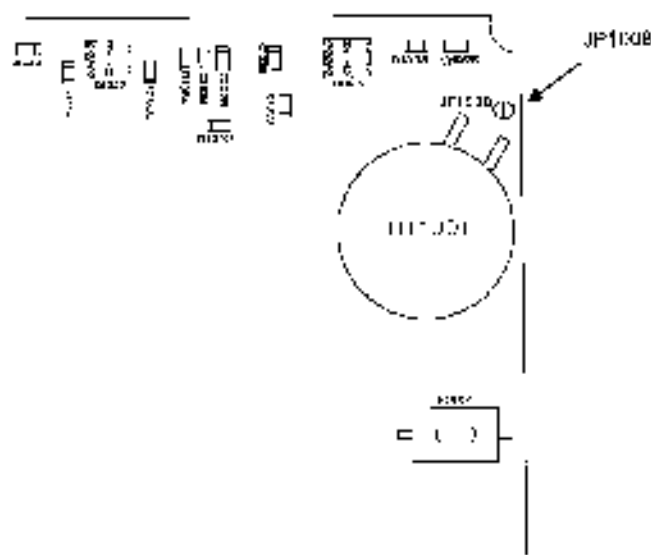
This completes the internal alignment routine, to save all settings and exit, press **[MD]**, the frequency display will return to normal.

CPU Reset

As a last resort, if you are unable to gain control of the transceiver, the FT-51R can be reset from the keypad to clear all settings, memories, channel step and repeater shifts to their factory defaults.

To do this, hold **[MR]**, **[VFO]** and **[2]** depressed while turning on the transceiver. If CPU problems remain after performing the soft reset, a hard CPU reset may be performed as follows.

- Turn the transceiver off and disconnect all cables.
- Separate the front and rear transceiver body halves (as shown in *Transceiver Disassembly* on page 2-1).
- Remove the solder from jumper **JP1008** on the CNTL Unit near the lithium battery (as shown in the drawing).
- After waiting several minutes, resolder the jumper and reassemble the transceiver.



JP1008 Location

The FT-57R electronics consists of three major boards: the 144 and 430 (MHz) motherboards (or Mother Units) and the Control Unit, and numerous minor boards that mount on these. The motherboards include the receiver front ends, IF and PLL subsystem ICs, and support daughter boards for transmit stages, local VCOs, supply regulation and switching circuits. The Control Unit includes the microprocessors and tone generator/decoder chips, and supports daughter boards for the display, keys and keypad, audio circuits and an antenna board for coupling with the motherboards. While reading this description, you can refer to the block diagram for an overview of the major circuit blocks, and to the schematic diagrams for component details.

Antenna Duplexer

Tuning RF from the antenna jack passes through a 450-MHz low-pass filter on the 430 Mother Unit before application to two band-switching networks: coil L2008, diode D2003 & 3006 and capacitor C3040 on the 430 Mother Unit for UHF signals; and coil L2006, diode D2003 & 2207 and capacitor C2026 on the 144 Mother Unit for VHF signals. These networks filter VHF signals from the UHF receiver and UHF signals from the VHF receiver, allowing each band to operate independently while sharing the same antenna connection.

VHF Reception

VHF signals passed by the duplexer are applied to a varactor-tuned band-pass filter consisting of L2016 and L2019 before RF amplification by Q2032 (2SC4537). The amplified RF is then band-pass filtered again by varactor-tuned resonators L2015/D2018 and L2018 to ensure pure in-band input to 1st mixer Q2029/D2017 (2SC4537). Tuning voltage for the varactors is provided by VHF PLL Q2007, buffered by Q2014 (2SK880GR).

Unifreea 189.05 ~ 199.05-MHz output from the 144-VCO Unit is amplified by Q2002 (2SC4537) and applied to the 1st mixer. The resulting 45.03-MHz 1st mixer product is passed through monolithic crystal filter XT001 (~ 7.5-kHz BW) to strip away all but the desired signal, which is then amplified by Q2028 (2SC4215Y) before delivery to FM IF subsystem IC Q2031 (TK10930V), containing the 2nd mixer, 2nd local oscillator, limiter amplifier, noise amplifier, S-meter amplifier and squelch gates. A 2nd local signal is generated from 44.595-MHz crystal X2001, which produces the 455-kHz 2nd IF when mixed with the 1st IF signal within Q2031. The 2nd IF is passed through ceramic filter CT2001 to strip away unwanted mixer

products, and is then applied to the limiter amp in Q2031, which removes amplitude variations in the 455-kHz IF before detection of the speech by ceramic discriminator CD2001. Detected audio from pin 12 of Q2031 is delivered to the CNTL Unit.

VHF Squelch Control

When no carrier is received, noise at the output of the detector stage in Q2031 is amplified and band-pass filtered by the noise amp section of Q2031 and the network between pins 19 and 20, and then rectified by D2013. The resulting DC squelch control voltage is passed to pin 99 of Main CPU Q1002. While no carrier is received, pin 54 of Q1002 remains low, signaling pin 8 of Sub CPU Q1001 (M38223E4HP) on the Control Unit to keep the green (Busy) half of the VIT LED off, and holding the AF MUTE line low to block VIT receiver audio from passing through analog gate Q1015-1 while no signal is being received, and during transmission.

When a carrier appears at the discriminator, noise is removed from the output, causing pin 54 of Q1002 to go high and signaling microprocessor Q1001 to activate the BUSY LED. The microprocessor then checks CTCSS chip Q1004 (AK2343) and DTMF decoder chip Q1007 (TC35305F) for CTCSS or DTMF code squelch information, respectively. If not transmitting and tone squelch is not activated, or if the received tone matches that programmed, the microprocessor stops scanning, if active, and allows audio to pass through muting and amplifier IC Q1023 (TDA7243D) to the loudspeaker.

VHF Single-Band Dual Receive

When VIT single-band dual receive operation is active, a portion of the received VHF RF passing through the antenna switching network (and applied to the VIT front end) is sampled through diodes D2005 on the 144 Mother Unit and D3007 on the 430 Mother Unit, the signals are band-pass filtered and amplified by Q3013 (2SC4226) before application to mixer Q3014 (2SC4215Y). This mixer also receives output from the 430-VCO Unit, after it is divided by four in Q3024 (μ PB587G) on the 430-Mother Unit. The resulting 53.523-MHz sub-receiver 1st IF signal is applied to the UHF receiver IF chain before monolithic filter XT001, and is then handled just as a UHF signal would be in L-FR operation.

AF Output

On the CNTL Unit, detector audio from either the 144 or 430 Mother Unit is applied through analog switch Q1015-1 or -2 ($\frac{1}{4}$ NJU4068BV) to remove the

Circuit Description

CTCSS tone, if present, and adds keypad beeps and DTMF monitor tones as needed. The resulting audio is delivered through the respective volume control and audio selector Q1006 (MB87078PF) on the CNTL Unit, which selects VHF and UHF audio on the internal or external (EAR jack) loudspeakers, separate or mixed, through Q1018, Q1019 (2SC4617x2) and audio amplifier Q1023 (TDA7233D) on the CN1L Unit.

UHF Reception

UHF signals passed by the duplexer are applied to a varactor-tuned band-pass filter consisting of L3029, TC3005 and D3021/D3025 before RF amplification by Q3009 (2SC4228). The amplified RF is then band-pass filtered again by varactor-tuned resonators LC3004, L3028, D3023, D3024 and TC3003, L3027, D3019, D3023, further amplified by Q3036 (2SC4228) and filtered once more by TC3002, L3026, D3018 and D3022 to ensure pure in-band input to 1st mixer Q3035 (2SC4228). Tuning voltage for the varactors is provided by UHF PLL Q3009, buffered by Q3015 (2SK880GR).

Buffered output between 391.475 – 391.475-MHz from the 430-VCO Unit is amplified by Q3003 (2SC4245) and applied to the 1st mixer. The resulting 58.525-MHz 1st mixer product is passed through monolithic crystal filter XF3001 (17.5-kHz BW) to strip away all but the desired signal, which is then amplified by Q3004 (2SC4215Y) before delivery to FM IF subsystem IC Q3037 (MC3372VM), which contains the 2nd mixer, 2nd local oscillator, limiter amplifier, noise amplifier, S-meter amplifier and squelch gates.

A 2nd local signal is generated from 56.07 MHz crystal X3002, which produces the 455-kHz 2nd IF when mixed with the 1st IF signal within Q3037. The 2nd IF is passed through ceramic filter CF3001 to strip away unwanted mixer products, and is then applied to the limiter amp in Q3037, which removes amplitude variations in the 455-kHz IF before detection of the speech by ceramic discriminator CD3001.

Detected audio from pin 9 of Q3037 is delivered via the 430 Mother Unit, CONTACT Unit and CNTL Unit (for sampling by CTCSS & DTMF detectors and de-emphasis). Receiver audio amplification is as already described.

UHF Squelch Control

When no carrier is received, noise at the output of the detector stage in Q3037 is amplified and band-pass filtered by the noise amp section of Q3037 and

the network between pins 9 and 10, and then rectified by D3014. The resulting DC squelch control voltage is passed to pin 98 of main CPU Q1002. While no carrier is received, pin 55 of Q1002 remains low, signaling pin 7 of sub-CPU Q1001 on the Control Unit to keep the green (Busy) half of the UHF LED off, and holding the AF MUTE line low to block UHF receiver audio from passing through analog gate Q1015.2 while no signal is being received, as well as during transmission.

When a carrier appears at the discriminator, noise is removed from the output, causing pin 55 of Q1002 to go high and signaling microprocessor Q1001 to activate the BUSY LED. The microprocessor then checks CTCSS chip Q1004 (AK2343) and DTMF decoder chip Q1007 (TC35305F) for CTCSS or DTMF code squelch information, respectively. If not transmitting and tone squelch is not activated, or if the received tone matches that programmed, the microprocessor stops scanning, if active, and allows audio to pass through mute and amplifier IC Q1023 (TDA7233D) to the loudspeaker.

UHF Single-Band Dual Receive

When UHF single-band dual receive operation is active, a portion of the received UHF RF passing through the antenna switching network (and applied to the UHF front end) is sampled via diode D2308 on the 144 Mother Unit and diode D3026 on the 430 Mother Unit. Here, the signals are band-pass filtered and amplified by Q2017 and Q2018 (both 2SC4227) before application to mixer Q2016 (2SC4537). This mixer also receives the third harmonic of the 144 VCO Unit. The resulting 45.05-MHz sub-receiver 1st IF signal is applied to the VHF receiver IF chain just before monolithic filter XF2001, and is then handled just as a VHF signal would be in VHF operation.

Transmitter Audio Stages

Speech input from the microphone is delivered to Q1006 (MB87078PF) for pre-emphasis then passes through the splatter filter section within Q1004 and Q1006 (MB87078PF) for IDC (instantaneous deviation control) before delivery to the modulator.

If Tone Burst or DTMF is enabled for transmission, the tone is generated by main CPU Q1002, buffered by Q1001 and applied to the IDC stage in place of speech audio. Also, the tone is amplified for monitoring in the loudspeaker, as mentioned before. The sub-CPU closes Mic Mute gate Q1004 when transmitting a tone, or when transmission is disabled.

The modulating audio is delivered first to the Control Unit, where it may pick up a generated CTCSS tone, then is next delivered to both Mother Units, where it is either disabled (on the receiving band) by Q2003 (VHIF) or Q23004 (UHIF, both DTC142EE), or delivered to modulating varactors D3003 (in the UHIF VCO) or D4003 (in the VHIF VCO), frequency modulating the PLL carrier up to ± 5 kHz from the unmodulated carrier at the transmitting frequency.

Late VHIF Transmit Stages

On the 144 VCO Unit, the modulated signal from VHF VCO Q4001 (2SC4226) is buffered by Q4002 and Q4003 (both 2SC4226) and returned to the 144 Mother Unit for amplification by Q2002 (2SC4537), and then final amplification by VHIF PA module Q2001 (S-AV28) on the 144 Mother Unit. The transmit signal then passes through antenna t/r switch D2003 before returning to the duplexer network on the 144 Mother Unit and then a low-pass filter consisting of L2002, L3003, C2017, C2018, C2012 and the duplexer consisting of C2019 (mounted on the 144 Mother Unit) and L3010, C3031, C3165 and the LPF (L3004, L3005, C3027, C3028, C3014) mounted on the 430 Mother Unit, before delivery to the antenna.

VHF Automatic Transmit Power Control (APC)

RF power output from the VHF final amplifier is sampled and rectified by D2001 (1SS321). The resulting DC is fed back through Q2004 (2SA1586) and Q2008 (2SC4617) to driver Q2002 (2SC4537) on the 144 Mother Unit, controlling the level of drive to the PA module, and thus the power output. The microprocessor selects either high or one of four low power levels via Q2011 (XP1401).

When the VHF transmitter PLL is unlocked, or while receiving, the unlock signal from Q2007 causes the ULT3V line to be dropped via Q2006 (DTA124EE), and Q2013 (DTC124EE), which disables transmission by biasing final amplifier Q2001 off and opening VHF t/r switch D2003.

VHF Transmit/Receive Switching

Closing the PTT switch on the Key Unit pulls one side of the microphone low, which turns on Q1010 (DTA144EE), causing pin 95 of microprocessor Q1002 on the Control Unit to go high. The microprocessor then delivers appropriate serial data to sub-CPU Q1001 to raise the TXV line to the 144 Mother Unit (via the Contact Unit) where Q2020 (UMB10) turns off the receiver, and Q2023 (DTC144EE) and Q2015 (DTA123RH) turn on the transmitter. This tx signal is delivered to the 144 Mother Unit where it causes the

ULT3V line to go high, which in turn biases the VHIF PA module on and closes t/r switch D2003 on the 144 Mother Unit. At the same time, Q2005 on the 144 Mother Unit turns on Q2002 on the 144 Mother Unit to drive the PA module.

Late UHIF Transmit Stages

On the 430 VCO Unit, the modulated signal from LHF VCO Q5001 (2SC5006) is buffered by Q5005 and Q5002 (2SC5006) and returned to the 430 Mother Unit for amplification by Q3003 (2SC4245), and then final amplification by UHF PA module Q3002 (M87799MA) on the 430 Mother Unit. The transmit signal then passes through antenna t/r switch D3003 before returning to the duplexer network and the high-pass filter consisting of L3003-3005, C3021, C3022, C3014, C3027-3028, C3165 and the high-pass filter consisting of L3009, L3012, C3010, C3011, C3020 and C3029, mounted on the 430 Mother Unit before delivery to the antenna.

UHF Automatic Transmit Power Control (APC)

RF power output from the UHF final amplifier is sampled and rectified by D3001 (1SS321). The resulting DC is fed back through Q3005 (A1586Y) and Q3008 (2SC4617) to driver Q3001 (2SC4537) and Q3003 (2SC4245) on the 430 Mother Unit, controlling the level of drive to the PA module, and thus the power output. The microprocessor selects either high or one of four low power levels via Q3011 (XP1401).

When the UHF PLL is unlocked, or while receiving, the unlock signal causes the ULT3U line to be dropped via Q3007 (DTA144EE), and Q3012 (DTC124EE), which disables the transmitter by biasing final amplifier Q3002 off and opening LHF t/r switch D3003.

UHF Transmit/Receive Switching

As for LHF, closing the PTT line raises the TXU line via Q1010 and Q1002 on the Control Unit. This line connects to the 430 Mother Unit (via the Contact Unit) where Q3026 (UMB10N) turns off the receiver, and Q3017 (XP4213) and Q3022 (UMB10N) turn on the transmitter. This tx signal is delivered to the 430 Mother Unit where it causes the ULT3U line to go high, which in turn biases the UHF PA module on and closes t/r switch D3003 on the 430 Mother Unit. At the same time, Q3004 on the 430 Mother Unit turns on Q3003, Q3001 on the 430 Mother Unit to drive the PA module.

Circuit Description

VHF PLL Frequency Synthesizer

The VHF PLL circuitry consists of VCO Q4001 and VCO buffer Q4003 (both 2SC4228) on the 144 VCO Unit; PLL subsystem IC Q2007 (FQ7925) on the 144 Mother Unit, and 12.8-MHz reference oscillator X3001/Q3009 on the 430 Mother Unit. Q2007 contains a prescaler, reference divider, serial-to-parallel data latch, programmable divider, phase comparator, charge pump, band selector and a power saver circuit.

While receiving, VCO Q4001 oscillates between 189.05 and 199.05 MHz according to the transceiver version and the programmed receiving frequency. The VCO output is buffered by Q4003 and returned to the 144 Mother Unit, where a sample of that output is applied to the prescaler section of Q2007. There the VCO signal is divided by 64 or 65, according to a control signal from the data latch section of Q2007, before being applied to the programmable divider section of Q2007.

The data latch section of Q2007 also receives serial dividing data from sub-cpu Q1001 on the Control Unit, which causes the pre-divided VCO signal to be further divided in the programmable divider section, depending upon the desired receive frequency, so as to produce a 5-kHz or 6.25-kHz derivative of the current VCO frequency. Meanwhile, the reference divider section of Q2007 divides the 12.8-MHz crystal reference from the 430 Mother Unit, after buffering by Q3036 (2SC4617), by 2560 (or 2048) to produce the 5-kHz (or 6.25-kHz) loop reference (respectively).

The 3-kHz (or 6.25-kHz) signal from the programmable divider (derived from the VCO) and that derived from the reference oscillator are applied to the phase detector section of Q2007, which produces a pulsed output with pulse duration depending on the phase difference between the input signals. This pulse train is filtered to DC and returned to varactor D4001 on the 144 VCO Unit.

Changes in the level of the DC voltage applied to the varactors affect the reactance in the tank circuit of the VCO, changing the oscillating frequency of the VCO according to the phase difference between the signals derived from the VCO and the crystal reference oscillator. The VCO is thus phase-locked to the crystal reference oscillator.

The output of VCO Q4001, after buffering by Q4002 and Q4003, is delivered to the 144 Mother Unit for amplification by Q2002 before application to the 1st mixer, as described previously.

For VITF transmission, VCO Q4001 oscillates between 140 and 150 MHz according to the model version and programmed transmit frequency. The remainder of the PLL circuitry is shared with the receiver. However, the dividing data from the microprocessor is such that the VCO frequency is at the actual transmit frequency (rather than offset for IFs, as in the receiving case). Also, the VCO is modulated by the speech audio applied to D4003, as described previously. Receive and transmit buses select which VCO is made active by Q4004 (DTC143ZE). FET Q2011 (2SK880GR) on the 144 Mother Unit buffers the VCV line for application to the tracking band-pass filters in the receiver front end.

When the power saving feature is active, the microprocessor periodically signals the PLL IC to conserve power and shorten lock-up time.

UHF PLL Frequency Synthesizer

The UHF PLL circuitry consists of VCO Q5001 and VCO buffers Q5002 and Q5003 (all 2SC5006) on the 430 VCO Unit, and PLL subsystem IC Q3009 (FQ7925) and 12.8-MHz reference oscillator X3001 on the 430 Mother Unit. Q3009 contains a prescaler, reference divider, serial-to-parallel data latch, programmable divider, phase comparator, band selector and a power saver circuit.

For receiving, VCO Q5001 oscillates between 488.525 and 508.525 MHz according to model version and the programmed receiving frequency. A portion of the VCO output is buffered by Q5003 and returned to the prescaler section of Q3009 on the 430 Mother Unit. There the VCO signal is divided by 64 or 65, according to a control signal from the data latch section of Q3009, before being applied to the programmable divider section of Q3009.

The data latch section of Q3009 also receives serial dividing data from sub-cpu Q1001 on the Control Unit, which causes the pre-divided VCO signal to be further divided in the programmable divider section, depending upon the desired receive frequency, so as to produce a 5-kHz or 6.25-kHz derivative of the current VCO frequency. Meanwhile, the reference divider section of Q3009 divides the 12.8-MHz crystal reference by 2560 (or 2048) to produce the 5-kHz (or 6.25-kHz) loop reference (respectively).

The 5-kHz (or 6.25-kHz) signal from the programmable divider (derived from the VCO) and that derived from the reference oscillator are applied to the phase detector section of Q3009, which produces a dual pulsed output with pulse duration depending on the phase difference between the input signals.

This pulse train is filtered to DC and returned to varactor D5001 on the 430 VCO Unit.

Changes in the level of the DC voltage applied to the varactors affect the reactance in the tank circuit of the VCO, changing the oscillating frequency of the VCO according to the phase difference between the signals derived from the VCO and the crystal reference oscillator. The VCO is thus phase-locked to the crystal reference oscillator.

The output of VCO Q5001 is also buffered by Q5002 & Q5003 and is then delivered to the 430 Mother Unit for amplification by Q3003 before application to the 1st mixer, as described previously.

For UHF transmission, VCO Q5001 oscillates between 430 and 450 MHz according to the model version and programmed transmit frequency. The remainder of the PLL circuitry is shared with the receiver. However, the dividing data from the microprocessor is such that the VCO frequency is at the actual transmit frequency (rather than offset for IFs,

as in the receiving case). Also, for transmission, the VCO is modulated by the filtered speech audio applied to the tank circuit at D5003, as described previously. Receive and transmit buses select which VCO is to be active by Q5004 (DTC143ZE), respectively. HFT Q3015 (2SK880GR) on the 430 Mother Unit buffers the VCV line for application to the tracking band-pass filters in the receiver front end.

When the power saving feature is active, the microprocessor periodically signals the PLL IC to conserve power and shorten lock up time.

Power-On Sequencing

Pressing the orange POWER switch applies 3 volts to POWER SW pin 94 of microprocessor Q1002 to wake it up. This provides 3 volts via Q1017 (XP4312) on the Control Unit. At the same time, Q1002 provides 3 V via regulator IC Q2022 and Q2023 (both TK11230M) on the 144 and 430 Mother Units.

Parts List

REF.	DESCRIPTION	VALUE	REV	QTY.	MANUFACTURER	YAESU P/N	YDRS.	QTY.	DATE
*** CNTL UNIT ***									
	PCB With Components	(W/ KEY, MIC UNIT)				CS1416002	TYP A1		
	PCB With Components	(W/ KEY, MIC UNIT)				CS1416003	TYP A2		
	PCB With Components	(W/ KEY, MIC UNIT)				CS1416004	TYP A3		
	PCB With Components	(W/ KEY, MIC UNIT)				CS1416005	TYP 01		
	PCB With Components	(W/ KEY, MIC UNIT)				CS1416006	TYP 02		
	PCB With Components	(W/ KEY, MIC UNIT)				CS1416007	TYP 03		
	PCB With Components	(W/ KEY, MIC UNIT)				CS1416008	TYP 01		
	PCB With Components	(W/ KEY, MIC UNIT)				CS1416009	TYP 02		
	PCB With Components	(W/ KEY, MIC UNIT)				CS1416010	TYP 03		
	PCB With Components	(W/ KEY, MIC UNIT)				CS1416011	TYP 01		
	PCB With Components	(W/ KEY, MIC UNIT)				CS1416012	TYP 02		
	Printer Circuit Board					P3681101			
DT1001	LITHIUM BATTERY				CR1216 1R6	Q9000627			
C 1001	CHIP CAP.	0.001uF	25V	5	TKK105B102K-V	K22145820			
C 1002	CHIP CAP.	0.001uF	25V	5	TKK105B102K-V	K22145820			
C 1003	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1004	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1005	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1006	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1007	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1008	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1009	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1010	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1011	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1012	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1013	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1014	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1015	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1016	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1017	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1018	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1019	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1020	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1021	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1022	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1023	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1027	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1031	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1032	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1033	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1034	CHIP CAP.	0.001uF	25V	3	TKK105B102K-F	K22145820			
C 1035	CHIP CAP.	47pF	50V	CH	TKK105B102K-F	K22145820			
C 1036	CHIP CAP.	27pF	25V	CH	TKK105B102K-F	K22145820			
C 1037	CHIP CAP.	39pF	25V	CH	TKK105B102K-F	K22145820			
C 1038	CHIP CAP.	22pF	50V	CH	TKK105B102K-F	K22145820			

CNTL Unit

REF.	DESCRIPTION	VALUE	RV	TOL.	REFERENCE DESIGN	YAESU P/N	VERS.	LOC. LAY ADR
C 1039	CHIP CAP.	0.001uF	25V	B	TKK1053102K-F	322144820		
C 1040	CHIP CAP.	47pF	50V	CE	32X393C147C150PT	322174227		
C 1042	CHIP CAP.	0.001uF	50V	B	32X39B1C2K50PT	322174809		
C 1043	CHIP CAP.	100pF	50V	CE	32X393C151C150PT	322174233		
C 1044	CHIP CAP.	0.01uF	25V	B	32X39B1C3K25PT	322144802		
C 1045	CHIP CAP.	0.01uF	25V	B	32X39B1C3K25PT	322144802		
C 1046	CHIP CAP.	0.1uF	25V	D	32X40B1C4K25PT	322140811		
C 1047	CHIP CAP.	0.1uF	25V	B	32X40B1C4K25PT	322140811		
C 1048	CHIP CAP.	0.1uF	25V	B	32X40B1C4K25PT	322140811		
C 1049	CHIP CAP.	0.1uF	25V	B	32X40B1C4K25PT	322140811		
C 1050	TANTALUM CHIP CAP.	1uF	16V		TEMSVA1C105M1-82	378120009		
C 1051	CHIP CAP.	0.1uF	25V	D	32X40B1C4K25PT	322140811		
C 1052	CHIP CAP.	0.001uF	50V	B	32X39B1C2K50PT	322174809		
C 1053	TANTALUM CHIP CAP.	1uF	16V		TEMSVA21C105K-8M	378120024		
C 1054	TANTALUM CHIP CAP.	1uF	16V		TEMSVA1C105M1-82	378120009		
C 1055	CHIP CAP.	0.01uF	25V	B	32X39B1C3K25PT	322144802		
C 1056	CHIP CAP.	0.001uF	50V	B	32X39B1C2K50PT	322174809		
C 1057	TANTALUM CHIP CAP.	1uF	16V		TEMSVA21C105K-8M	378120024		
C 1058	TANTALUM CHIP CAP.	1uF	16V		TEMSVA21C105K-8M	378120024		
C 1059	CHIP CAP.	23pF	50V	CE	32X393C23C150PT	322174223		
C 1060	CHIP CAP.	470pF	50V	CE	32X393C471C150PT	322174249		
C 1061	CHIP CAP.	0.047uF	16V	F	TKK105F475Z-F	322129002		
C 1062	CHIP CAP.	0.001uF	25V	B	TKK1053102K-F	322144820		
C 1063	CHIP CAP.	0.22uF	16V	J	GRM40B224K13PT	322120803		
C 1064	CHIP CAP.	0.012uF	25V	3	GRM39B183K25PT	322144803		
C 1065	TANTALUM CHIP CAP.	0.8uF	4V		TEMSVA20G883K-8R	378060022		
C 1066	CHIP CAP.	0.001uF	50V	B	GRM39B1C2K50PT	322174809		
C 1067	CHIP CAP.	0.01uF	25V	B	GRM39B1C3K25PT	322144802		
C 1068	TANTALUM CHIP CAP.	0.8uF	4V		TEMSVA20G883K-8R	378060022		
C 1069	TANTALUM CHIP CAP.	0.8uF	4V		TEMSVA20G883K-8R	378060022		
C 1070	TANTALUM CHIP CAP.	0.8uF	4V		TEMSVA20G883K-8R	378060022		
C 1071	CHIP CAP.	0.001uF	50V	3	GRM39B102K50PT	322174803		
C 1072	TANTALUM CHIP CAP.	0.8uF	4V		TEMSVA20G883K-8R	378060022		
C 1074	CHIP CAP.	0.01uF	25V	3	GRM39B103K25PT	322144802		
C 1075	CHIP CAP.	0.01uF	25V	3	GRM39B1C3K25PT	322144802		
C 1076	CHIP CAP.	100pF	50V	CH	GRM393-101C150PT	322174236		
C 1077	CHIP CAP.	0.01uF	25V	3	GRM40B104K25PT	322140811		
C 1078	CHIP CAP.	0.01uF	25V	B	GRM40B104K25PT	322144802		
C 1079	CHIP CAP.	0.01uF	25V	B	GRM40B104K25PT	322140811		
C 1080	TANTALUM CHIP CAP.	22uF	4V		TEMSVAC3223K-5R	378060023		
C 1081	CHIP CAP.	0.001uF	25V	B	TKK105B1C23-F	322144820		
C 1082	CHIP CAP.	0.01uF	25V	B	GRM393-103K25PT	322144802		
C 1083	CHIP CAP.	0.001uF	50V	D	32X39B1C2K50PT	322174809		
C 1084	CHIP CAP.	0.001uF	50V	B	32X39B1C2K50PT	322174809		
C 1085	CHIP CAP.	0.001uF	50V	B	32X39B1C2K50PT	322174809		
C 1086	CHIP CAP.	0.001uF	25V	B	TKK105B1C2K-F	322144820		
C 1087	TANTALUM CHIP CAP.	10uF	5.0V		TEMSVA5J105M-8R	378060027		
C 1088	CHIP CAP.	0.1uF	25V	3	32X40B1C4K25PT	322140811		
C 1089	CHIP CAP.	0.1uF	25V	B	32X40B1C4K25PT	322140811		

REF.	DESCRIPTION	VALUE	WV	LOC.	MANUFACTURER'S DESIGN	FASSO P/K	VRRL	LOC. LIST AND
C 1090	TANTALUM CHIP CAP.	1uF	16V		TEKSYA21C1C5M-B3	K78120024		
C 1091	CHIP CAP.	0.001uF	30V	B	GRM39B1C2M50PT	K22174809		
C 1092	TANTALUM CHIP CAP.	5.8uF	4V		TEKSYA2C0385M-B3	K78036022		
C 1093	CHIP CAP.	0.001uF	25V	B	TKX105B102X-F	K22148820		
C 1094	CHIP CAP.	0.001uF	30V	B	GRM39B1C2M50PT	K22174809		
C 1095	CHIP CAP.	0.047uF	25V	F	GRM39F473225PT	K22145002		
C 1096	CHIP CAP.	0.001uF	30V	B	GRM39B1C2M50PT	K22174809		
C 1097	TANTALUM CHIP CAP.	4uF	16V		TEKSYD21C476M124	K78120027		
C 1098	TANTALUM CHIP CAP.	4.7uF	6.3V		TEKSYA3J475M-8R	K78036017		
C 1099	CHIP CAP.	0.001uF	30V	B	GRM39B1C2M50PT	K22174809		
C 1100	CHIP CAP.	0.001uF	30V	B	GRM39B1C2M50PT	K22174809		
C 1101	CHIP CAP.	0.001uF	50V	D	GRM39D1C2M50PT	K22174809		
C 1102	TANTALUM CHIP CAP.	4.7uF	6.3V		TEKSYA3J475M-8R	K78036017		
C 1103	CHIP CAP.	0.001uF	50V	B	GRM39B1C2M50PT	K22174809		
C 1104	TANTALUM CHIP CAP.	10uF	16V		TEKSYE21C1C5M-B3	K78120025		
C 1105	CHIP CAP.	0.001uF	50V	B	GRM39B1C2M50PT	K22174809		
C 1106	CHIP CAP.	0.001uF	25V	B	TKX105B102X-F	K22148820		
C 1107	CHIP CAP.	0.001uF	50V	B	GRM39B1C2M50PT	K22174809		
C 1108	TANTALUM CHIP CAP.	100uF	6.3V		TEKSYD2CJ1C7M123	K78036033		
C 1109	CHIP CAP.	22pF	50V	CE	GRM39CH320J50FT	K22174219		
C 1110	CHIP CAP.	22pF	50V	CE	GRM39CH320J50FT	K22174219		
C 1111	CHIP CAP.	22pF	50V	CE	GRM39CH320J50FT	K22174219		
C 1112	CHIP CAP.	0.1uF	25V	D	GRM40D1C4M25PT	K22140511		
C 1113	CHIP CAP.	0.1uF	25V	D	GRM40D1C4M25PT	K22140511		
C 1114	TANTALUM CHIP CAP.	4.7uF	16V		TEKSYA1C475M-8R	K78120031		
C 1115	CHIP CAP.	0.001uF	50V	B	GRM39B1C2M50PT	K22174809		
C 1116	TANTALUM CHIP CAP.	150uF	4V		TEKSYC2C03157M124	K78036018		
C 1117	CHIP CAP.	0.001uF	50V	B	GRM39B1C2M50PT	K22174809		
C 1118	CHIP CAP.	0.001uF	50V	B	GRM39B1C2M50PT	K22174809		
C 1119	CHIP CAP.	0.047uF	50V	B	GRM40B473M50PT	K22174052		
C 1120	CHIP CAP.	0.22uF	6V	B	GRM40B224M15PT	K22120808		
C 1121	TANTALUM CHIP CAP.	10uF	6.3V		TEKSYA3J106M-B3	K78036027		
C 1122	CHIP CAP.	0.001uF	50V	B	GRM39B1C2M50PT	K22174809		
C 1123	CHIP CAP.	0.001uF	50V	B	GRM39B1C2M50PT	K22174809		
C 1124	TANTALUM CHIP CAP.	47uF	16V		TEKSYD21C475M122	K78120027		
C 1125	CHIP CAP.	0.001uF	50V	B	GRM39B1C2M50PT	K22174809		
C 1126	TANTALUM CHIP CAP.	47uF	16V		TEKSYD21C475M122	K78120027		
C 1127	CHIP CAP.	0.001uF	30V	B	GRM39D102M50PT	K22174809		
C 1128	CHIP CAP.	0.047uF	25V	F	GRM39F473225PT	K22145002		
C 1129	CHIP CAP.	0.047uF	25V	F	GRM39F473225PT	K22145002		
C 1130	CHIP CAP.	0.001uF	25V	B	TKX105B102X-F	K22148820		
C 1131	CHIP CAP.	100pF	25V	CE	TKX105CH10J-F	K22148238		
C 1132	CHIP CAP.	0.1uF	25V	B	GRM40D1C4M25PT	K22140511		
C 1133	CHIP CAP.	0.001uF	25V	D	TKX105D102X-F	K22148820		
C 1134	CHIP CAP.	100pF	25V	CE	TKX105CH10J-F	K22148238		
C 1135	CHIP CAP.	100pF	25V	CE	TKX105CH10J-F	K22148238		
C 1136	CHIP CAP.	100pF	25V	CE	TKX105CH10J-F	K22148238		
C 1137	CHIP CAP.	100pF	25V	CE	TKX105CH10J-F	K22148238		
C 1138	CHIP CAP.	0.001uF	25V	B	TKX105D102X-F	K22148820		

CNTL Unit

REF.	DESCRIPTION	VALUE	WV	TOL.	REFR'S DWG.S	YASCO P/N	VERSL.	LOT.	LAY	ADD.
C 1139	CHIP CAP.	100pF	50V	CH	GRM39CH1C1J50PT	K22174235				
C 1140	CHIP CAP.	100pF	50V	CH	GRM39CH1C1J50PT	K22174235				
C 1141	CHIP CAP.	100pF	50V	CH	GRM39CH1C1J50PT	K22174235				
C 1142	CHIP CAP.	100pF	25V	CH	TKX105CH101J-F	K22148238				
C 1143	CHIP CAP.	100pF	25V	CH	TKX105CH101J-F	K22148238				
C 1144	CHIP CAP.	C.001uF	25V	A	TKK105B102K-F	K22148820				
C 1145	CHIP CAP.	C.001uF	25V	A	TKK105B102K-F	K22148820				
C 1146	CHIP CAP.	C.001uF	25V	A	TKK105B102K-F	K22148820				
C 1147	CHIP CAP.	C.001uF	25V	D	TKK105B102K-F	K22148820				
C 1148	CHIP CAP.	C.001uF	25V	B	TKK105B102K-F	K22148820				
C 1149	CHIP CAP.	C.001uF	25V	B	TKK105B102K-F	K22148820				
C 1150	CHIP CAP.	C.001uF	25V	B	TKK105B102K-F	K22148820				
C 1151	CHIP CAP.	C.001uF	25V	D	TKK105B102K-F	K22148820				
C 1152	CHIP CAP.	C.001uF	50V	B	33X39B1C2K50FT	K22174809				
C 1153	CHIP CAP.	100pF	50V	CH	33X39CF101J50PT	K22174235				
C 1154	CHIP CAP.	C.001uF	50V	D	33X39B1C2K50FT	K22174809				
C 1155	CHIP CAP.	C.001uF	25V	B	TKK105B102K-F	K22148820				
C 1156	TANTALUM CHIP CAP.	47.2F	16V		TE83V0210A76K12D	K78120027				
C 1157	CHIP CAP.	C.001uF	25V	D	TKK105B102K-F	K22148820				
C 1158	CHIP CAP.	100pF	25V	CH	TKK105CH101J-F	K22148238				
C 1159	CHIP CAP.	100pF	25V	CH	TKK105CH101J-F	K22148238				
C 1160	CHIP CAP.	C.001uF	25V	D	TKK105B102K-F	K22148820				
C 1161	CHIP CAP.	C.001uF	25V	D	TKK105B102K-F	K22148820				
C 1162	CHIP CAP.	C.001uF	25V	D	TKK105B102K-F	K22148820				
CNTCH1	GRAPHIC OSC				CSA13L 58M03300A-FC	H7900790				
CNTCH2	GRAPHIC OSC				CSA13A 19M0 TC	H7901510				
D 1001	LED				L1348	G2070596				
D 1002	LED				CL-135J2/G-D-T	G2070278				
D 1003	LED				CL-135J2/G-D-T	G2070278				
D 1004	DIODE				MMK11 TK	G2070198				
D 1005	DIODE				MMK11 TK	G2070198				
D 1006	DIODE				HV2001P6 1685A	G2070348				
D 1007	DIODE				MA111-(TK)	G2070338				
D 1008	LED				LV1371SC-(CRP)	G2070386				
D 1009	LED				LV1371SC-(CRP)	G2070386				
D 1010	LED				LV1371SG-(CRP)	G2070386				
D 1011	LED				LV1371SG-(CRP)	G2070386				
D 1012	LED				LV1371SG-(CRP)	G2070386				
D 1013	LED				LV1371SG-(CRP)	G2070386				
D 1014	LED				LV1371SG-(CRP)	G2070386				
D 1015	DIODE				1S9319 1E853	G2070380				
D 1016	DIODE				MA111-(TK)	G2070338				
D 1017										
D 1018	DIODE				DA821 TL	G2070178				
D 1019	DIODE				MA729-(TK)	G2070320				
D 1020	DIODE				DA821 TL	G2070178				
D 1021	DIODE				MA728-(TK)	G2070320				

REF.	DESCRIPTION	VALUE	WV	TOL.	PCOM'S DESIGN	WASSED P/E	VEES.	LOC.	LAY	ADR.
DS1001	DSO				PSD 13344	850901.1				
J 1001	CONNECTION				22FL2-SM1-TC	P10003553				
J 1002	CONNECTION				ES11458-C1-C10	P10003700				
J 1001	RESIST	470Ohm			PL032T-47LC	L10003805				
Q 1001	IC				M38A23F4-132HP	61081982	DST USA			C-3
Q 1001	IC				M38A23F4-132HP	61081982	DST EX.			C-3
Q 1002	IC				IC5473877H B3027	61081985				C-2
Q 1003	IC				X2401358-2.7-T	61081931				C-2
Q 1004	IC				AK2343	61081908				C-4
Q 1005	IC				XJU4056BV-TCL	61081870				C-4
Q 1006	IC				ME87078PF-Q-BND-ER	61081773				D-2
Q 1007	IC				TC36306V-11-TP2	61081197				D-2
Q 1008	FET				CPA07C-T1	61070003				D-3
Q 1009	TRANSISTOR				DTA1432E TL	61070102				D-1
Q 1010	TRANSISTOR				DTA1445E TL	61070054				D-2
Q 1011	IC				S-81233SC-Q-T1	61081938				C-1
Q 1012	IC				S-80730SN-DT-T1	61081875				C-1
Q 1013	TRANSISTOR				ZSB1132 T100 Q	61211327Q				C-2
Q 1014	TRANSISTOR				X2401358-2.7-T	61081931				C-2
Q 1015	IC				XJU4056BV-TCL	61081870				D-4
Q 1016	IC				S-80730SN-D2-T1	61081878				C-3
Q 1017	TRANSISTOR				X2401358-2.7-T	61081931				D-2
Q 1018	TRANSISTOR				ZSB4617 TL B	61081981				D-1
Q 1019	TRANSISTOR				ZSB4617 TL B	61081981				D-1
Q 1020	TRANSISTOR				ZSB4617 TL B	61081981				D-4
Q 1021	TRANSISTOR				ZSB1132 T100 Q	61211327Q				D-1
Q 1022	TRANSISTOR				ZSB4617 TL B	61081981				C-1
Q 1023	IC				TDA7233C-TR	61081112				D-1
Q 1024	TRANSISTOR				DTA1445E TL	61070054				C-1
Q 1025	TRANSISTOR				X2401358-2.7-T	61081931				C-1
Q 1026	TRANSISTOR				DTA1432E TL	61070102				D-1
Q 1027	IC				ZSB204-T1B	61070208				C-1
Q 1028	TRANSISTOR				ZSB1774 TL B	61077783				C-1
Q 1029	IC				S-8435CP-SD-T1	61081871				C-2
Q 1030	IC				S-80730SN-DT-T1	61081875				C-1
Q 1031	TRANSISTOR				ZSB4617 TL B	61081981				C-2
Q 1032	TRANSISTOR				DTA1445E TL	61070054				D-2
Q 1033	TRANSISTOR				DTA1432E TL	61070102				D-2
P 1001	CHIP RES.	100K	1/10W	0.5%	RR051CR-104-D	J24189156				
R 1002	CHIP R-S.	100K	1/10W	0.5%	RR051CR-104-D	J24189157				
R 1003	CHIP RES.	100K	1/10W	0.5%	RR051CR-104-D	J24189157				
R 1004	CHIP RES.	22K	1/10W	0.5%	RR051CR-223-D	J24189151				
R 1005	CHIP RES.	C	1/10W		RM01/188 JPTH	J24189070				
R 1006	CHIP RES.	100K	1/10W	5%	RM01/188 154.TH	J24189051				

AW.	DESCRIPTION	VALUE	WV	TOL.	REFS'S DESIG	YAKSU I/A	WRES.	LOC. DAY ADR
R 1007	CHIP RES.	1M	1/10W	5%	RNC1/10S 100JTH	J24189051		
R 1008	CHIP RES.	100K	1/10W	0.5%	RNC5100-104-C	J2418918Y		
R 1009	CHIP RES.	8.2K	1/10W	0.5%	RNC510P-522-C	J24189141		
R 1010	CHIP RES.	5.6K	1/10W	0.5%	RNC510P-562-C	J24189137		
R 1011	CHIP RES.	100K	1/10W	0.5%	RNC5102-104-C	J24189167		
R 1012	CHIP RES.	150	1/10W	5%	RNC1/10 181JATP	J24189181		
R 1013	CHIP RES.	150	1/10W	5%	RNC1/10 181JATP	J24189181		
R 1014	CHIP RES.	22K	1/10W	0.5%	RNC5102-223-C	J24189151		
R 1015	CHIP RES.	330K	1/10W	5%	RNC1/10S 334JTH	J24189055		
R 1016	CHIP RES.	150K	1/10W	5%	RNC1/10S 154JTH	J24189051		
R 1017	CHIP RES.	0.6K	1/10W	0.5%	RNC510P-392-C	J24189133		
R 1018	CHIP RES.	100K	1/10W	5%	RNC1/10S 154JTH	J24189051		
R 1019	CHIP RES.	22K	1/10W	0.5%	RNC5100-223-C	J24189151		
R 1020	CHIP RES.	22K	1/10W	0.5%	RNC5102-223-C	J24189151		
R 1021	CHIP RES.	1M	1/10W	5%	RNC1/10S 100JTH	J24189051		
R 1022	CHIP RES.	2.2K	1/10W	0.5%	RNC510P-222-C	J2418912Y		
R 1023	CHIP RES.	2.2K	1/10W	0.5%	RNC510P-222-C	J24189127		
R 1024	CHIP RES.	100K	1/10W	0.5%	RNC5102-104-C	J2418915Y		
R 1025	CHIP RES.	100K	1/10W	0.5%	RNC5102-104-C	J2418915Y		
R 1026	CHIP RES.	50K	1/10W	0.5%	RNC5100-563-C	J24189151		
R 1027	CHIP RES.	1K	1/10W	5%	RNC1/10S 100JTH	J24189051		
R 1028	CHIP RES.	150K	1/10W	5%	RNC1/10S 154JTH	J24189051		
R 1029	CHIP RES.	150K	1/10W	5%	RNC1/10S 154JTH	J24189051		
R 1030	CHIP RES.	3.9K	1/10W	0.5%	RNC510P-392-C	J24189133		
R 1031	CHIP RES.	100K	1/10W	0.5%	RNC5102-104-C	J2418915Y		
R 1032	CHIP RES.	3.9K	1/10W	0.5%	RNC510P-392-C	J24189133		
R 1033	CHIP RES.	100K	1/10W	0.5%	RNC5102-104-C	J2418915Y		
R 1034	CHIP RES.	47K	1/10W	0.5%	RNC510P-473-C	J24189158		
R 1035	CHIP RES.	100K	1/10W	0.5%	RNC5102-104-C	J2418915Y		
R 1036	CHIP RES.	470K	1/10W	5%	RNC1/10S 474JTH	J2418905Y		
R 1037	CHIP RES.	470K	1/10W	5%	RNC1/10S 474JTH	J2418905Y		
R 1038	CHIP RES.	470K	1/10W	5%	RNC1/10S 474JTH	J2418905Y		
R 1039	CHIP RES.	470K	1/10W	5%	RNC1/10S 474JTH	J2418905Y		
R 1040	CHIP RES.	470K	1/10W	5%	RNC1/10S 474JTH	J2418905Y		
R 1041	CHIP RES.	470K	1/10W	5%	RNC1/10S 474JTH	J2418905Y		
R 1042	CHIP RES.	47K	1/10W	0.5%	RNC5102-473-C	J24189158		
R 1043	CHIP RES.	33K	1/10W	0.5%	RNC5102-333-C	J24189155		
R 1044	CHIP RES.	100	1/10W	0.5%	RNC510P-101-C	J24189055		
R 1045	CHIP RES.	2.2K	1/10W	0.5%	RNC510P-222-C	J24189127		
R 1046	CHIP RES.	2.2K	1/10W	0.5%	RNC510P-222-C	J24189127		
R 1048	CHIP RES.	470	1/10W	0.5%	RNC510P-473-C	J24189111		
R 1049	CHIP RES.	470K	1/10W	5%	RNC1/10S 474JTH	J24189057		
R 1050	CHIP RES.	470K	1/10W	5%	RNC1/10S 474JTH	J24189057		
R 1051	CHIP RES.	2.2K	1/10W	0.5%	RNC510P-222-C	J24189127		
R 1052	CHIP RES.	15K	1/10W	5%	RNC1/10 153JATP	J24189153		
R 1053	CHIP RES.	220K	1/10W	5%	RNC1/10 224JATP	J24189224		
R 1054	CHIP RES.	15K	1/10W	0.5%	RNC5102-153-C	J2418914Y		
R 1055	CHIP RES.	10K	1/10W	0.5%	RNC5102-103-C	J24189143		
R 1056	CHIP RES.	15K	1/10W	0.5%	RNC5102-153-C	J2418914Y		

REF.	DESCRIPTION	VALUE	W	TOL.	PROGRAM DESIGN	YAKSG V/V	W/V/S.	LOT.	DAY	AGE
R 1057	CHIP RES.	2.2K	1/16W	0.5%	BR0510F-222-D	J24189127				
R 1058	CHIP RES.	470K	1/16W	5%	BR01/16S 474JTH	J24189057				
R 1059	CHIP RES.	120	1/16W	0.5%	BR0510F 121-D	J24189097				
R 1060	CHIP RES.	6.8K	1/16W	0.5%	BR0510F-682-D	J24189199				
R 1061	CHIP RES.	10K	1/16W	0.5%	BR0510F-103-D	J24189143				
R 1062	CHIP RES.	2.2K	1/16W	0.5%	BR0510F-222-D	J24189127				
R 1063	CHIP RES.	33K	1/16W	0.5%	BR0510F 333-D	J24189155				
R 1064	CHIP RES.	150K	1/16W	5%	BR01/16S 154JTH	J24189051				
R 1065	CHIP RES.	820K	1/16W	5%	BR01/16S 854JTH	J24189059				
R 1066	CHIP RES.	10K	1/16W	0.5%	BR0510F-103-D	J24189143				
R 1067	CHIP RES.	4.7K	1/16W	0.5%	BR0510F 472-D	J24189135				
R 1068	CHIP RES.	2.2K	1/16W	0.5%	BR0510F-222-D	J24189127				
R 1069	CHIP RES.	47K	1/16W	0.5%	BR0510R-473-D	J24189153				
R 1070	CHIP RES.	0	1/16W		BR01/16S 0PTH	J24189070				
R 1072	CHIP RES.	270K	1/16W	5%	BR01/16S 274JTH	J24189054				
R 1073	CHIP RES.	820K	1/16W	5%	BR01/16S 824JTH	J24189050				
R 1074	CHIP RES.	120	1/16W	0.5%	BR0510F 121-D	J24189097				
R 1075	CHIP RES.	4.7K	1/16W	0.5%	BR0510F 472-D	J24189135				
R 1076	CHIP RES.	100	1/16W	0.5%	BR0510F-101-D	J24189095				
R 1077	CHIP RES.	100K	1/16W	0.5%	BR0510R-104-D	J24189167				
R 1078	CHIP RES.	100K	1/16W	0.5%	BR0510R-104-D	J24189167				
R 1080	CHIP RES.	1K	1/16W	5%	BR01/16S 105JTH	J24189061				
R 1082	CHIP RES.	1K	1/16W	0.5%	BR0510F-102-D	J24189118				
R 1083	CHIP RES.	1K	1/16W	0.5%	BR0510F 102-D	J24189119				
R 1084	CHIP RES.	470	1/16W	5%	BR01/16S 471JATP	J24189471				
R 1085	CHIP RES.	470	1/16W	5%	BR01/16S 471JATP	J24189471				
R 1086	CHIP RES.	470	1/16W	5%	BR01/16S 471JATP	J24189471				
R 1087	CHIP RES.	470	1/16W	5%	BR01/16S 471JATP	J24189471				
R 1088	CHIP RES.	100K	1/16W	0.5%	BR0510R 104-D	J24189167				
R 1089	CHIP RES.	560	1/16W	5%	BR01/16S 561JATP	J24189568				
R 1090	CHIP RES.	560	1/16W	5%	BR01/16S 561JATP	J24189568				
R 1091	CHIP RES.	560	1/16W	5%	BR01/16S 561JATP	J24189568				
R 1092	CHIP RES.	560	1/16W	5%	BR01/16S 561JATP	J24189568				
R 1093	CHIP RES.	33K	1/16W	0.5%	BR0510R 333-D	J24189155				
R 1094	CHIP RES.	560	1/16W	5%	BR01/16S 561JATP	J24189568				
R 1095	CHIP RES.	560	1/16W	5%	BR01/16S 561JATP	J24189568				
R 1096	CHIP RES.	560	1/16W	5%	BR01/16S 561JATP	J24189568				
R 1097	CHIP RES.	1K	1/16W	0.5%	BR0510F-102-D	J24189119				
R 1098	CHIP RES.	1K	1/16W	0.5%	BR0510F 102-D	J24189119				
R 1099	CHIP RES.	22K	1/16W	0.5%	BR0510R-223-D	J24189151				
R 1100	CHIP RES.	22K	1/16W	0.5%	BR0510R-223-D	J24189151				
R 1101	CHIP RES.	100K	1/16W	0.5%	BR0510R-104-D	J24189167				
R 1102	CHIP RES.	100K	1/16W	0.5%	BR0510R-104-D	J24189167				
R 1103	CHIP RES.	15K	1/16W	0.5%	BR0510R-153-D	J24189147				
R 1104	CHIP RES.	4.7K	1/16W	0.5%	BR0510F 472-D	J24189135				
R 1105	CHIP RES.	4.7K	1/16W	0.5%	BR0510F-472-D	J24189135				
R 1106	CHIP RES.	390K	1/16W	5%	BR01/16S 394JATP	J24189058				
R 1107	CHIP RES.	1.5K	1/16W	0.5%	BR0510F 152-D	J24189123				
R 1108	CHIP RES.	4.7K	1/16W	0.5%	BR0510F-472-D	J24189135				

CNTL Unit

REF.	DESCRIPTION	VALUE	#	TOL.	MFG.'S DESIG.	YAESU P/N	VERS.	LOC.	LAY	ADR.
B 1109	CHIP RES.	3.3K	1/16W	0.5%	REC51CP-332-D	J24189131				
B 1110	CHIP RES.	3.3K	1/16W	0.5%	REC51CP-332-D	J24189131				
B 1111	CHIP RES.	1K	1/16W	0.5%	REC51CP-102-D	J24189119				
R 1112	CHIP RES.	1K	1/16W	0.5%	REC51CP-102-D	J24189119				
R 1113	CHIP RES.	4.7K	1/16W	0.5%	REC51CP-472-D	J24189135				
R 1114	CHIP RES.	2.2K	1/16W	0.5%	REC51CP-222-D	J24189127				
R 1115	CHIP RES.	10K	1/16W	0.5%	REC51CP-103-D	J24189143				
R 1116	CHIP RES.	220	1/16W	0.5%	REC51CP-221-D	J24189163				
R 1117	CHIP RES.	4.7	1/16W	5%	REC1/16S 4.7%	J24205479				
R 1118	CHIP RES.	220	1/16W	0.5%	REC51CP-221-D	J24189163				
R 1119	CHIP RES.	1K	1/16W	5%	REC1/16S 100JTH	J24189004				
R 1120	CHIP RES.	1K	1/16W	5%	REC1/16S 100JTH	J24189004				
R 1121	CHIP RES.	1K	1/16W	5%	REC1/16S 100JTH	J24189004				
R 1122	CHIP RES.	1K	1/16W	5%	REC1/16S 100JTH	J24189004				
R 1123	CHIP RES.	47K	1/16W	0.5%	REC51CP-473-D	J24189139				
R 1124	CHIP RES.	100K	1/16W	0.5%	REC51CP-104-D	J24189187				
R 1125	CHIP RES.	150K	1/16W	5%	REC1/16S 150JTH	J24189051				
R 1126	CHIP RES.	10K	1/16W	0.5%	REC51CP-103-D	J24189143				
R 1127	CHIP RES.	100K	1/16W	0.5%	REC51CP-104-D	J24189187				
R 1128	CHIP RES.	C	1/16W	5%	REC1/16S 000JATP	J24189000				
R 1129	CHIP RES.	290K	1/16W	5%	REC1/16S 394JTH	J24189053				
R 1130	CHIP RES.	15K	1/16W	0.5%	REC51CP-153-D	J24189127				
R 1131	CHIP RES.	150K	1/16W	5%	REC1/16S 154JTH	J24189061				
R 1132	CHIP RES.	3.3K	1/16W	0.5%	REC51CP-332-D	J24189121				
R 1133	CHIP RES.	1K	1/16W	5%	REC1/16S 100JTH	J24189004				
R 1134	CHIP RES.	1K	1/16W	5%	REC1/16S 100JTH	J24189004				
R 1135	CHIP RES.	100K	1/16W	0.5%	REC51CP-104-D	J24189187				
R 1136	CHIP RES.	C	1/16W	5%	REC1/16S 000JATP	J24189000				
S 1001	TACT SWITCH				SOP-112EST	N5C90071				
S 1002	TACT SWITCH				SOP-112EST	N5C90071				
S 1003	TACT SWITCH				SOP-112EST	N5C90071				
S 1004	TACT SWITCH				SKQCA4	N5C90051				
S 1005	ROTARY CODE S.W.				SCC9P20-4B	N5C90053				
	HOLDER PLATE (JACK)					R3150230				
	HOLDER FRAME (CST)					R3150250				
	SHIELD PLATE (CST)					R3150810				
	SHIELD PLATE (CPL)					R3150820				
	MYLAR (R1)					R7150420				
	INTER CONNECTOR					R7150430				
	MYLAR (SP)					R7150930				

Parts List

REF.	DESCRIPTION	VALUE	WV	TOL.	MANUFACT. DESIG.	YAESU P/N	VERS.	LCT.	LAY	AMT.
*** 144 MOTHER UNIT ***										
	PCB With Components (w/ 144 w/o HV T)					075034001				
	Printed Circuit Board					P348C101				
C 2001	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	322148820				
C 2002	CHIP CAP.	22pF	25V	CH	TKK105CH220J-F	322148822				
C 2003	CHIP CAP.	100pF	25V	CH	TKK105CH100J-F	322148823				
C 2004	CHIP CAP.	100pF	25V	CH	TKK105CH100J-F	322148823				
C 2005	CHIP CAP.	0.5uF	25V	CH	TKK105CK025C-F	322148804				
C 2006	CHIP CAP.	0.5uF	25V	CH	TKK105CK025C-F	322148804				
C 2007	CHIP CAP.	100pF	25V	CH	TKK105CH100J-F	322148823				
C 2008	CHIP CAP.	18pF	25V	CH	TKK105CH180J-F	322148820				
C 2009	CHIP CAP.	100pF	25V	CH	TKK105CH100J-F	322148823				
C 2010	TANTALUM CHIP CAP.	4.7uF	6.3V		TEMSVAC0475M-82	375080017				
C 2011	CHIP CAP.	15pF	25V	CH	TKK105CH150J-F	322148815				
C 2012	CHIP CAP.	6pF	25V	CH	TKK105CH060J-F	322148810				
C 2013	TANTALUM CHIP CAP.	4.7uF	10V		TEMSVAL0475M-82	375100022				
C 2014	TANTALUM CHIP CAP.	0.1uF	35V		TESVAL0100M1-82	375160025				
C 2015	TANTALUM CHIP CAP.	0.1uF	35V		TESVAL0100M1-82	375160025				
C 2016	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	322148820				
C 2017	CHIP CAP.	39pF	25V	CH	TKK105CH390J-F	322148825				
C 2018	CHIP CAP.	39pF	25V	CH	TKK105CH390J-F	322148825				
C 2019	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	322148820				
C 2020	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	322148820				
C 2021	TANTALUM CHIP CAP.	10uF	6.3V		TEMSVAC100M-82	375080027				
C 2022	CHIP CAP.	56pF	25V	CH	TKK105CH560J-F	322148822				
C 2023	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	322148820				
C 2024	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	322148820				
C 2025	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	322148820				
C 2026	CHIP CAP.	22pF	25V	CH	TKK105CH220J-F	322148822				
C 2027	TANTALUM CHIP CAP.	4.7uF	6.3V		TEMSVAC0475M-82	375080017				
C 2028	TANTALUM CHIP CAP.	10uF	6.3V		TEMSVAC100M-82	375080027				
C 2029	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	322148820				
C 2030	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	322148820				
C 2031	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	322148820				
C 2032	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	322148820				
C 2033	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	322148820				
C 2036	CHIP CAP.	0.047uF	16V	F	ENK105F473Z-F	322128005				
C 2037	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	322148820				
C 2038	TANTALUM CHIP CAP.	1uF	10V		TESVAL0100M1-82	375160025				
C 2039	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	322148820				
C 2040	TANTALUM CHIP CAP.	4.7uF	6.3V		TEMSVAC0475M-82	375080017				
C 2041	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	322148820				
C 2042	CHIP CAP.	0.047uF	16V	F	ENK105F473Z-F	322128005				
C 2043	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	322148820				
C 2044	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	322148820				
C 2045	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	322148820				

144-MOTHER Unit

WKT.	DESCRIPTION	VALUE	VF	COL.	WPC'S BASIC	YARDU P/P	VERB.	LOT.	DAY	ADM.
C 2045	CHIP CAP.	8pF	25V	CH	TMK105CH0800-F	K22148212				
C 2048	CHIP CAP.	5pF	25V	CH	TMK105CH0500-F	K22148213				
C 2049	CHIP CAP.	6pF	25V	CH	TMK105CH0600-F	K22148210				
C 2050	CHIP CAP.	4pF	25V	CH	TMK105CH0400-F	K22148208				
C 2051	CHIP CAP.	3pF	25V	CH	TMK105CH0300-F	K22148207				
C 2052	CHIP CAP.	5pF	25V	CH	TMK105CH0500-F	K22148210				
C 2053	CHIP CAP.	2pF	25V	CH	TMK105CH0200-F	K22148206				
C 2054	CHIP CAP.	5pF	25V	CH	TMK105CH0500-F	K22148209				
C 2055	TACTALUM CHIP CAP.	3.3 pF	18V		TEMSVAC0335M-AR	K78120021				
C 2057	CHIP CAP.	0.001uF	25V	B	TMX105B102K-F	K22148820				
C 2058	CHIP CAP.	0.001uF	25V	B	TMX105B102K-F	K22148820				
C 2059	CHIP CAP.	2pF	25V	CH	TMX105CH0200-F	K22148206				
C 2060	CHIP CAP.	7pF	25V	CH	TMX105CH0700-F	K22148211				
C 2061	CHIP CAP.	4pF	25V	CH	TMX105CH0400-F	K22148208				
C 2063	CHIP CAP.	0.001uF	25V	B	TMX105B102K-F	K22148820				
C 2064	TACTALUM CHIP CAP.	100pF	4V		TEMSVAC0010TYL2R	K78060021				
C 2065	CHIP CAP.	0.001uF	25V	B	TMX105B102K-F	K22148820				
C 2066	CHIP CAP.	0.01uF	18V	B	TMX105B103K-F	K22128802				
C 2067	CHIP CAP.	0.001uF	25V	B	TMX105B102K-F	K22148820				
C 2068	CHIP CAP.	5pF	25V	CH	TMX105CH0500-F	K22148209				
C 2069	CHIP CAP.	4pF	25V	CH	TMX105CH0400-F	K22148208				
C 2070	CHIP CAP.	0.001uF	25V	B	TMX105B102K-F	K22148820				
C 2071	CHIP CAP.	0.001uF	25V	B	CRM403104M25PT	K22140811				
C 2072	CHIP CAP.	330pF	25V	B	TMX105B330K-F	K22148814				
C 2073	CHIP CAP.	0.01uF	50V	B	CRM403103M50PT	K22170817				
C 2074	CHIP CAP.	0.047uF	16V	F	EMX105F173Z-F	K22125002				
C 2075	CHIP CAP.	0.001uF	25V	B	TMX105B102K-F	K22148820				
C 2076	CHIP CAP.	330pF	25V	B	TMX105B330K-F	K22148814				
C 2077	TACTALUM CHIP CAP.	4.7uF	6.3V		TEMSVAC0475M-AR	K78060019				
C 2078	TACTALUM CHIP CAP.	10uF	6.3V		TEMSVAC0105M-AR	K78060027				
C 2079	CHIP CAP.	0.053uF	25V	B	CRM403333M25PT	K22140810				
C 2080	CHIP CAP.	0.001uF	25V	B	TMX105B102K-F	K22148820				
C 2081	CHIP CAP.	0.01uF	18V	B	EMX105B103K-F	K22128802				
C 2082	CHIP CAP.	47pF	25V	CH	TMX105CH4700-F	K22148230				
C 2083	CHIP CAP.	9pF	25V	CH	TMX105CH0900-F	K22148209				
C 2084	CHIP CAP.	3pF	25V	CH	TMX105CH0300-F	K22148207				
C 2085	CHIP CAP.	0.001uF	25V	B	TMX105B102K-F	K22148820				
C 2087	CHIP CAP.	0.01uF	18V	B	EMX105B103K-F	K22128802				
C 2088	CHIP CAP.	1pF	25V	CH	TMX105CH0100-F	K22148205				
C 2089	CHIP CAP.	0.001uF	25V	B	TMX105B102K-F	K22148820				
C 2090	CHIP CAP.	150pF	16V	CH	EMX105CH151J-F	K22128206				
C 2091	CHIP CAP.	0.001uF	25V	B	TMX105B102K-F	K22148820				
C 2092	CHIP CAP.	33pF	25V	CH	TMX105CH3300-F	K22148228				
C 2093	CHIP CAP.	2pF	25V	CH	TMX105CH0200-F	K22148206				
C 2094	CHIP CAP.	0.1uF	25V	B	33M40B104M25PT	K22140811				
C 2095	CHIP CAP.	0.001uF	25V	B	TMX105B102K-F	K22148820				
C 2096	CHIP CAP.	22pF	25V	CH	TMX105CH2200-F	K22148222				
C 2098	CHIP CAP.	22pF	25V	CH	TMX105CH2200-F	K22148222				
C 2099	CHIP CAP.	65pF	25V	CH	TMX105CH6500-F	K22148234				

REF.	DESCRIPTION	VALUE	Qty	FO.	MFGGR'S DESIGN	YAESU P/N	REMARKS	LOT	DATE ACQ
C 2100	CHIP CAP.	0.001uF	25V	B	TKM105B102K-F	K22140820			
C 2101	CHIP CAP.	0.1uF	25V	B	33K40B104K25PT	K22140811			
C 2102	CHIP CAP.	0.1uF	25V	B	33K40B104K25PT	K22140811			
C 2103	CHIP CAP.	0.1uF	25V	B	33K40B104K25PT	K22140811			
C 2104	CHIP CAP.	0.1uF	25V	B	33K40B104K25PT	K22140811			
C 2105	CHIP CAP.	0.001uF	25V	B	TKM105B102K-F	K22140820			
C 2106	CHIP CAP.	33pF	25V	CH	TKM105CE100C-F	K22140821			
C 2107	CHIP CAP.	0.001uF	25V	B	TKM105B102K-F	K22140820			
C 2108	CHIP CAP.	0.001uF	25V	B	TKM105B102K-F	K22140820			
C 2109	CHIP CAP.	0.01uF	10V	B	TKM105B102K-F	K22128802			
C 2110	CHIP CAP.	0.001uF	25V	B	TKM105B102K-F	K22140820			
C 2111	CHIP CAP.	0.001uF	25V	B	TKM105B102K-F	K22140820			
C 2112	CHIP CAP.	10pF	25V	CH	TKM105CE100C-F	K22140821			
C 2113	CHIP CAP.	0.01uF	10V	B	TKM105B102K-F	K22128802			
C 2114	TANTALUM CHIP CAP.	10uF	6.3V		TKMSV40J106M 8R	K78060067			
C 2115	CHIP CAP.	100pF	10V	CH	TKM105CE100C-F	K22128804			
C 2116	TANTALUM CHIP CAP.	47uF	10V		TKMSV021C476M123	K78120027			
C 2118	CHIP CAP.	0.001uF	25V	B	TKM105B102K-F	K22140820			
C 2119	CHIP CAP.	18pF	25V	CH	TKM105CE150C-F	K22140820			
C 2121	CHIP CAP.	0.001uF	25V	B	TKM105B102K-F	K22140820			
C 2122	CHIP CAP.	0.001uF	25V	B	TKM105B102K-F	K22140820			
C 2123	CHIP CAP.	0.001uF	25V	B	TKM105B102K-F	K22140820			
C 2125	CHIP CAP.	100pF	25V	CH	TKM105CE100C-F	K22140820			
C 2126	CHIP CAP.	0.001uF	25V	B	TKM105B102K-F	K22140820			
C 2127	CHIP CAP.	0.001uF	25V	B	TKM105B102K-F	K22140820			
C 2135	CHIP CAP.	0.001uF	25V	B	TKM105B102K-F	K22140820			
C 2136	CHIP CAP.	0.001uF	25V	B	TKM105B102K-F	K22140820			
C 2138	CHIP CAP.	0.002uF	25V	B	GRM405333M25PT	K22140810			
C 2139	TANTALUM CHIP CAP.	10uF	6.3V		TKMSV40J106M 8R	K78060027			
C 2140	CHIP CAP.	0.001uF	25V	B	TKM105B102K-F	K22140820			
C 2141	CHIP CAP.	100pF	25V	CH	TKM105CE100C-F	K22140820			
CD2001	CDMA C DISC				CDMA4050V1	H7800010			
C2001	CERAMIC FILTER				CPWF435F	E0900305			
D 2001	DIODE				1SS321 TS85R	G2070075			
D 2002	DIODE				1SS321 TS85R	G2070075			
D 2003	DIODE				RLS135 TS-11	G2070125			
D 2004	DIODE				CR023 0% T035R	G2070144			
D 2006	DIODE				HS1277	G2070115			
D 2007	DIODE				RLS135 TS-11	G2070125			
D 2008	DIODE				HS1277	G2070115			
D 2009	DIODE				BA6222 TL	G2070174			
D 2010	DIODE				BA6222 TL	G2070174			
D 2011	DIODE				BA6222 TL	G2070174			
D 2012	DIODE				BA6222 TL	G2070174			
D 2013	DIODE				1SS302 T-85W	G2070086			
D 2014	DIODE				MA111 (TS)	G2070335			

144-MOTHER Unit

REF.	DESCRIPTION	VALUE	WV	TOL.	MFG.'S DESIG.	YASCO P/N	FEES.	LOT.	DAY	ADR
D 2015	DIODE				1SS302 T885Z	62370088				
D 2016	DIODE				PA221 TL	62370178				
D 2017	DIODE				HFC350-TR	62370380				
D 2018	DIODE				HFC350-TR	62370380				
D 2019	DIODE				HV202A TL	62370332				
D 2021	DIODE				KAL11-(TX)	62370358				
D 2022	DIODE				KAL11-(TX)	62370358				
C 2001	CONNECTOR				92508-1-052071-T	P0091041				
C 2002	CONNECTOR				22PS-JK1	P0091007				
L 2001	R. 3FC	0.052uF			WV015 1082K	L1690197				
L 2002	COIL				6.572, HCC, SUREX 3	L0021803a				
L 2003	COIL				6.572, CDC, SUREX 3	L0021803a				
L 2004	R. 3FC	240uH			FL032T-22-LJ	L1690231				
L 2005	R. 3FC	1uH			LE50137130M	L1690119				
L 2006	COIL				6.572, HCC, SUREX 3	L0020730A				
L 2007	R. 3FC	0.052uF			EX2125 82NA-T	L1690385				
L 2009	R. 3FC	0.012uF			EX2125 12NA-T	L1690375				
L 2010	R. 3FC	0.015uF			EX2125 12NA-T	L1690375				
L 2011	R. 3FC	0.012uF			EX2125 12NA-T	L1690378				
L 2012	R. 3FC	0.015uF			EX2125 12NA-T	L1690379				
L 2013	R. 3FC	0.22uH			L3R0157W224	L1690111				
L 2014	R. 3FC	0.22uH			EX2125 12NA-T	L1690313				
L 2015	COIL				X5-07528	L0022307				
L 2016	COIL				X5-07467	L0022308				
L 2017	R. 3FC	0.07uH			L3R0157W474	L1690115				
L 2018	COIL				X5-07467	L0022308				
L 2019	R. 3FC	1.0uH			EX2125 16CK-T	L1690319				
Q 2001	IC				8-AV28	61091962				A-2
Q 2002	TRANSISTOR				2SC4537 TL	63345377				C-3
Q 2003	TRANSISTOR				DTA124B5 TL	63070109				B-3
Q 2004	TRANSISTOR				2SA1385Y T885R	63115887Y				D-2
Q 2005	TRANSISTOR				2SB132 P100 2	632113272				A-2
Q 2006	TRANSISTOR				DTA124B5 TL	63070110				C-2
Q 2007	IC				PC9725 -	61091710				C-2
Q 2008	TRANSISTOR				2SC4617 TL 5	63346178F				D-2
Q 2010	TRANSISTOR				XP1501-(TX)	63070143				D-2
Q 2011	TRANSISTOR				XP1401-(TX)	63070142				D-3
Q 2012	TRANSISTOR				3DF10N TV	63070108				C-2
Q 2013	TRANSISTOR				3DF124 TV TL	63070109				D-2
Q 2014	FET				2SK2800R T885R	63808807B				C-2
Q 2015	TRANSISTOR				DTA123E2 TL	63070144				A-3
Q 2016	TRANSISTOR				2SC4537 TM	63345377				C-2
Q 2017	TRANSISTOR				2SC4227-T20 R32	63342277B				D-2
Q 2018	TRANSISTOR				2SC4227-T20 R32	63342277B				D-2
Q 2019	IC				TC476510 TE12L	61091376				D-3
Q 2020	TRANSISTOR				3DF10N TV	63070108				C-3

PRC.	DESCRIPTION	VALUE	WT	QTY.	MOTHER'S DCS G	YR-SL F/R	PKGS.	LOC.	DAY	AGE
Q 2021	IC				707500P1 T385R	31C91527				C-2
Q 2022	IC				7K1123DM	31C91656				B-3
Q 2023	TRANS. 8703				DP0144KS TL	33C70075				C-3
Q 2024	TRANS. 8703				DP0143KS TL	33C70093				B-3
Q 2025	TRANS. 8703				DP08V TL	33C70145				C-2
Q 2026	TRANSISTOR				235-132 T100 Q	332113276				A-3
Q 2027	TRANSISTOR				XP1501-(C)	33C70143				A-3
Q 2028	TRANS. 8703				230X215V T-95M	3334215V				C-2
Q 2029	TRANSISTOR				230X537 TR	33345377				C-2
Q 2030	TRANSISTOR				CM01M TL	33C70113				C-1
Q 2031	IC				7K10900VTL	31C91605				B-1
Q 2032	TRANS. 8703				230X537 TR	33345377				B-1
Q 2033	TRANS. 8703				DP0124KK TL	33C70109				A-3
Q 2034	IC				7A75001V T385R	31C91383				D-3
Q 2035	TRANSISTOR				230X517 TL R	33345175B				C-3
R 2001	CHIP RES.	10K	1/16W	0.5%	RC0510P-103-D	J24189143				
R 2002	CHIP RES.	4.7K	1/16W	0.5%	RC0510P-473-D	J24189136				
R 2003	CHIP RES.	4.7K	1/16W	0.5%	RC0510P-473-D	J24189135				
R 2004	CHIP RES.	6.5K	1/16W	0.5%	RC0510P-653-D	J24189138				
R 2005	CHIP RES.	6.5K	1/16W	0.5%	RC0510P-653-D	J24189136				
R 2006	CHIP RES.	4.7K	1/16W	0.5%	RC0510P-473-D	J24189135				
R 2007	CHIP RES.	4.7K	1/16W	0.5%	RC0510P-473-D	J24189135				
R 2008	CHIP RES.	4.7K	1/16W	0.5%	RC0510P-473-D	J24189135				
R 2009	CHIP RES.	6.5K	1/16W	0.5%	RC0510P-653-D	J24189138				
R 2010	CHIP RES.	200	1/16W	0.5%	RC0510P-201-D	J24189108				
R 2011	CHIP RES.	10	1/16W	5%	RC0116S-100JTH	J24189001				
R 2012	CHIP RES.	650	1/16W	0.5%	RC0510P-651-D	J24189115				
R 2013	CHIP RES.	47	1/16W	5%	RC0116S-470JTH	J24189008				
R 2014	CHIP RES.	470	1/16W	0.5%	RC0510P-471-D	J24189111				
R 2015	CHIP RES.	100P	1/16W	0.5%	RC0510P-104-D	J24189167				
R 2016	CHIP RES.	68	1/10W	5%	RC0116S-680J	J24200580				
R 2017	CHIP RES.	3.3K	1/16W	0.5%	RC0510P-332-D	J24189131				
R 2018	CHIP RES.	1K	1/16W	0.5%	RC0510P-102-D	J24189119				
R 2019	CHIP RES.	1K	1/16W	0.5%	RC0510P-102-D	J24189119				
R 2020	CHIP RES.	10K	1/16W	0.5%	RC0510P-103-D	J24189143				
R 2021	CHIP RES.	1.5K	1/16W	0.5%	RC0510P-152-D	J24189123				
R 2022	CHIP RES.	3.3K	1/16W	0.5%	RC0510P-332-D	J24189131				
R 2023	CHIP RES.	1K	1/16W	0.5%	RC0510P-102-D	J24189119				
R 2024	CHIP RES.	1K	1/16W	0.5%	RC0510P-102-D	J24189119				
R 2025	CHIP RES.	180K	1/16W	5%	RC0116S-184JTH	J24189052				
R 2027	CHIP RES.	10K	1/16W	0.5%	RC0510P-103-D	J24189143				
R 2028	CHIP RES.	2.2K	1/16W	0.5%	RC0510P-222-D	J24189127				
R 2029	CHIP RES.	1K	1/16W	0.5%	RC0510P-102-D	J24189119				
R 2030	CHIP RES.	680	1/16W	0.5%	RC0510P-681-D	J24189115				
R 2031	CHIP RES.	1K	1/16W	0.5%	RC0510P-102-D	J24189119				
R 2032	CHIP RES.	10K	1/16W	0.5%	RC0510P-103-D	J24189143				
R 2033	CHIP RES.	22K	1/16W	0.5%	RC0510P-223-D	J24189151				
R 2034	CHIP RES.	180K	1/16W	5%	RC0116S-184JTH	J24189052				

144-MOTHER Unit

REF.	DESCRIPTION	VALUE	PU	COL.	PROGRAMS DISC	Y409L P/N	Y409L	Y409L	LOC. LAY. AGE
B 2035	CHIP RES.	10K	1/16W	C. 5%	BR0510P-100-D	J24189149			
B 2036	CHIP RES.	10K	1/16W	C. 5%	BR0510P-100-D	J24189149			
B 2037	CHIP RES.	47	1/16W	5%	3901/168 470JTH	J24189009			
B 2038	CHIP RES.	560	1/16W	C. 5%	BR0510P-561-D	J24189113			
B 2039	CHIP RES.	560	1/16W	C. 5%	BR0510P-561-D	J24189113			
B 2040	CHIP RES.	5.2K	1/16W	C. 5%	BR0510P-892-D	J24189141			
B 2041	CHIP RES.	10K	1/16W	C. 5%	BR0510P-100-D	J24189149			
B 2042	CHIP RES.	33K	1/16W	C. 5%	BR0510P-333-D	J24189155			
B 2043	CHIP RES.	33K	1/16W	C. 5%	BR0510P-333-D	J24189155			
B 2044	CHIP RES.	10K	1/16W	C. 5%	BR0510P-100-D	J24189149			
B 2045	CHIP RES.	10K	1/16W	C. 5%	BR0510P-100-D	J24189149			
B 2046	CHIP RES.	100K	1/16W	C. 5%	BR0510P-104-D	J24189167			
B 2047	CHIP RES.	2.7K	1/16W	C. 5%	BR0510P-272-D	J24189149			
B 2048	CHIP RES.	100K	1/16W	C. 5%	BR0510P-104-D	J24189167			
B 2049	CHIP RES.	4.7K	1/16W	C. 5%	BR0510P-472-D	J24189135			
B 2050	CHIP RES.	100K	1/16W	C. 5%	BR0510P-104-D	J24189167			
B 2051	CHIP RES.	100K	1/16W	C. 5%	BR0510P-104-D	J24189167			
B 2052	CHIP RES.	560	1/16W	C. 5%	BR0510P-561-D	J24189113			
B 2053	CHIP RES.	180K	1/16W	5%	3901/168 180JTH	J24189032			
B 2054	CHIP RES.	5.8K	1/16W	C. 5%	BR0510P-682-D	J24189139			
B 2055	CHIP RES.	580K	1/16W	5%	3901/168 580JTH	J24189059			
B 2056	CHIP RES.	4.7K	1/16W	C. 5%	BR0510P-472-D	J24189135			
B 2057	CHIP RES.	1.2K	1/16W	C. 5%	BR0510P-122-D	J24189121			
B 2058	CHIP RES.	1K	1/16W	C. 5%	BR0510P-100-D	J24189119			
B 2059	CHIP RES.	100K	1/16W	C. 5%	BR0510P-104-D	J24189167			
B 2060	CHIP RES.	180K	1/16W	5%	3901/168 180JTH	J24189032			
B 2061	CHIP RES.	2.2K	1/16W	C. 5%	BR0510P-222-D	J24189127			
B 2062	CHIP RES.	10K	1/16W	C. 5%	BR0510P-100-D	J24189149			
B 2063	CHIP RES.	10K	1/16W	C. 5%	BR0510P-100-D	J24189149			
B 2064	CHIP RES.	1.5K	1/16W	C. 5%	BR0510P-152-D	J24189123			
B 2065	CHIP RES.	4.7K	1/16W	C. 5%	BR0510P-472-D	J24189135			
B 2066	CHIP RES.	22K	1/16W	C. 5%	BR0510P-223-D	J24189131			
B 2067	CHIP RES.	100K	1/16W	C. 5%	BR0510P-104-D	J24189167			
B 2068	CHIP RES.	100K	1/16W	C. 5%	BR0510P-104-D	J24189167			
B 2069	CHIP RES.	100K	1/16W	C. 5%	BR0510P-104-D	J24189167			
B 2070	CHIP RES.	10K	1/16W	C. 5%	BR0510P-100-D	J24189149			
B 2071	CHIP RES.	10K	1/16W	C. 5%	BR0510P-100-D	J24189149			
B 2072	CHIP RES.	47K	1/16W	C. 5%	BR0510P-473-D	J24189158			
B 2073	CHIP RES.	1K	1/16W	C. 5%	BR0510P-100-D	J24189119			
B 2074	CHIP RES.	47K	1/16W	C. 5%	BR0510P-471-D	J24189111			
B 2075	CHIP RES.	47K	1/16W	C. 5%	BR0510P-473-D	J24189139			
B 2076	CHIP RES.	2.7K	1/16W	C. 5%	BR0510P-272-D	J24189129			
B 2077	CHIP RES.	1.8K	1/16W	C. 5%	BR0510P-182-D	J24189125			
B 2078	CHIP RES.	33K	1/16W	C. 5%	BR0510P-333-D	J24189157			
B 2079	CHIP RES.	100	1/16W	C. 5%	BR0510P-101-D	J24189095			
B 2080	CHIP RES.	10K	1/16W	C. 5%	BR0510P-100-D	J24189149			
B 2081	CHIP RES.	0	1/16W		3901/168 JPTH	J24189070			
B 2082	CHIP RES.	0	1/16W		3901/168 JPTH	J24189070			
B 2083	CHIP RES.	330	1/16W	C. 5%	BR0510P-331-D	J24189109			

REF.	DESCRIPTION	VALUE	WV	TOL.	REF'S DESIG.	YAESL P/N	VERS.	LOC.	LAY	ADR
R 2085	CHIP RES.	47K	1/16W	0.5%	REC5103-473-D	024189159				
R 2087	CHIP RES.	1K	1/16W	0.5%	REC510P-102-D	024189119				
R 2088	CHIP RES.	33K	1/16W	0.5%	REC510E-332-D	024189185				
R 2089	CHIP RES.	3.3K	1/16W	0.5%	REC510P-332-D	024189131				
R 2090	CHIP RES.	4.7K	1/16W	0.5%	REC510P-472-D	024189135				
R 2091	CHIP RES.	3.3K	1/16W	0.5%	REC510P-332-D	024189131				
R 2092	CHIP RES.	470K	1/16W	5%	REC5176S-474JTE	024189057				
TH2001	TRANSFORMER				137-203-55009TP	09090345				
VR2001	POT.	10K			KH03474-4201A	050785103				
X 2001	CRYST.	4.536MHz				EC102094				
XP2001	CRYST.				045015401	01102251				
	POWER PLATE (PCL)					EC150700				

Parts List

R.F.	DESCRIPTION	VALUE	W	TOL.	FRONT'S DESIGN	MANUFACTURER	QTY.	LOT.	EXP. DATE
*** 430-MOTHER UNIT ***									
	PCB With Components (W/430-MCU UNIT)						CP5035002	05T	USA
	PCB With Components (W/430-MCU UNIT)						CP5035003	05T	EXP
	Printed Circuit Board						F3479101		
C 3001	CHIP CAP.	0.001 μ F	25V	B	TKK105B102K-F		K22148820		
C 3002	CHIP CAP.	100pF	25V	CE	TKK105CH101-F		K22148838		
C 3003	CHIP CAP.	22pF	25V	CE	TKK105CH220-F		K22148822		
C 3004	CHIP CAP.	100pF	25V	CE	TKK105CH101-F		K22148836		
C 3005	CHIP CAP.	1pF	25V	CE	TKK105CH0100-F		K22148805		
C 3006	CHIP CAP.	0.5pF	25V	CE	TKK105CH0050-F		K22148804		
C 3007	CHIP CAP.	5pF	25V	CE	TKK105CH0500-F		K22148813		
C 3008	CHIP CAP.	100pF	25V	CE	TKK105CH101-F		K22148835		
C 3009	CHIP CAP.	15pF	25V	CE	TKK105CH150-F		K22148815		
C 3010	CHIP CAP.	5pF	25V	CH	TKK105CH050-F		K22148810		
C 3011	CHIP CAP.	5pF	25V	CH	TKK105CH0500-F		K22148813		
C 3012	CHIP CAP.	0.1 μ F	25V	A	GRN403104X25PT		K22140811		
C 3013	CHIP CAP.	3pF	25V	CH	TKK105CH0300-F		K22148807		
C 3014	CHIP CAP.	1pF	25V	CE	TKK105CH0100-F		K22148806		
C 3015	TANTALUM CHIP CAP.	100 μ F	4V		TEM5VAC00107H12R		K78050021		
C 3016	CHIP CAP.	1pF	25V	CE	TKK105CH0100-F		K22148806		
C 3017	CHIP CAP.	0.1 μ F	25V	B	GRN40B104X25PT		K22140811		
C 3018	TANTALUM CHIP CAP.	0.33 μ F	35V		TEM5V41V33H1-8R		K78160028		
C 3020	CHIP CAP.	22pF	25V	CE	TKK105CH220-F		K22148824		
C 3021	CHIP CAP.	3pF	25V	CE	TKK105CH0300-F		K22148812		
C 3022	CHIP CAP.	8pF	25V	CE	TKK105CH0800-F		K22148812		
C 3023	CHIP CAP.	0.001 μ F	25V	B	TKK105B102K-F		K22148820		
C 3024	CHIP CAP.	0.001 μ F	25V	B	TKK105B102K-F		K22148820		
C 3025	CHIP CAP.	0.001 μ F	25V	B	TKK105B102K-F		K22148820		
C 3026	CHIP CAP.	0.001 μ F	50V	B	GRN38B102X50PT		K22174809		
C 3027	CHIP CAP.	1pF	25V	CH	TKK105CH0100-F		K22148808		
C 3028	CHIP CAP.	5pF	25V	CH	TKK105CH0500-F		K22148809		
C 3029	CHIP CAP.	47pF	25V	CH	TKK105CH470-F		K22148830		
C 3030	CHIP CAP.	0.001 μ F	25V	B	TKK105B102K-F		K22148820		
C 3031	CHIP CAP.	1pF	25V	CE	TKK105CH0100-F		K22148806		
C 3032	TANTALUM CHIP CAP.	10 μ F	6.3V		TEM5VAC00103H-8R		K78080029		
C 3033	CHIP CAP.	5pF	25V	CE	TKK105CH0500-F		K22148810		
C 3034	CHIP CAP.	5pF	25V	CE	TKK105CH0500-F		K22148808		
C 3035	CHIP CAP.	0.001 μ F	25V	B	TKK105B102K-F		K22148820		
C 3036	TANTALUM CHIP CAP.	10 μ F	6.3V		TEM5VAC00106H-8R		K78080027		
C 3037	CHIP CAP.	15pF	25V	CH	TKK105CH150-F		K22148820		
C 3038	CHIP CAP.	0.001 μ F	25V	A	TKK105B102K-F		K22148820		
C 3039	CHIP CAP.	0.001 μ F	50V	B	GRN38B102X50PT		K22174809		
C 3040	CHIP CAP.	1pF	25V	CE	TKK105CH0100-F		K22148805		
C 3041	CHIP CAP.	15pF	25V	CH	TKK105CH150-F		K22148815		
C 3043	TANTALUM CHIP CAP.	4.7 μ F	6.3V		TEM5VAC00475H-8R		K78080027		
C 3044	TANTALUM CHIP CAP.	10 μ F	6.3V		TEM5VAC00106H-8R		K78080027		

430-MOTHER Unit

REF.	DESCRIPTION	VALUE	VOL	TOL.	MFGR'S DESIGN	WASD E/K	WES.	SUP.	BY ADD
C 3046	CHIP CAP.	2pF	25V	OK	TKK105CK0200-F	K22148206			
C 3047	CHIP CAP.	0.001uF	25V	B	TKK105B1023-F	K22148890			
C 3048	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	K22148820			
C 3049	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	K22148820			
C 3050	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	K22148820			
C 3051	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	K22148820			
C 3052	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	K22148820			
C 3053	CHIP CAP.	0.047uF	25V	F	EMK105P4733-F	K22129002			
C 3055	CHIP CAP.	18pF	25V	CE	TKK105CH1800-F	K22148220			
C 3056	CHIP CAP.	30pF	25V	CH	TKK105CH3000-F	K22148226			
C 3057	CHIP CAP.	4pF	25V	CH	TKK105CH0400-F	K22148208			
C 3058	CHIP CAP.	4pF	25V	CH	TKK105CH0400-F	K22148208			
C 3059	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	K22148820			
C 3060	CHIP CAP.	0.001uF	18V	F	EMK105P4733-F	K22129002			
C 3061	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	K22148820			
C 3062	CHIP CAP.	3pF	25V	CH	TKK105CH0300-F	K22148208			
C 3063	TANTALUM CHIP CAP.	15uF	6.3V		IRMSV5320J156M-83	K78180023			
C 3064	CHIP CAP.	1uF	18V	F	EMK105P105200-F	K22121001			
C 3065	CHIP CAP.	0.001uF	25V	B	TKK105B1023-F	K22148820			
C 3066	CHIP CAP.	0.001uF	25V	B	TKK105B1023-F	K22148820			
C 3067	CHIP CAP.	37pF	25V	CH	TKK105CH3700-F	K22148224			
C 3068	CHIP CAP.	0.001uF	25V	B	TKK105B1023-F	K22148820			
C 3069	CHIP CAP.	2pF	25V	OK	TKK105CK0200-F	K22148206			
C 3070	CHIP CAP.	0.001uF	25V	B	TKK105B1023-F	K22148820			
C 3071	CHIP CAP.	10pF	25V	CH	TKK105CH1000-F	K22148214			
C 3072	CHIP CAP.	4pF	25V	CH	TKK105CH0400-F	K22148208			
C 3074	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	K22148820			
C 3075	CHIP CAP.	0.001uF	30V	B	GRM40B103K50PT	K22170805			
C 3076	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	K22148820			
C 3077	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	K22148820			
C 3078	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	K22148820			
C 3079	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	K22148820			
C 3080	TANTALUM CHIP CAP.	10uF	4V		TSMSV006107M122	K78060021			
C 3081	CHIP CAP.	1pF	50V	OK	GRM39C301C50PT	K22174202			
C 3082	CHIP CAP.	8pF	25V	CH	TKK105CH0800-F	K22148210			
C 3084	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	K22148820			
C 3085	CHIP CAP.	0.001uF	30V	B	GRM40B103K50PT	K22170817			
C 3086	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	K22148820			
C 3087	CHIP CAP.	3pF	25V	CH	TKK105CH0300-F	K22148207			
C 3088	CHIP CAP.	3pF	25V	CH	TKK105CH0300-F	K22148207			
C 3089	CHIP CAP.	1pF	25V	OK	TKK105CK0100-F	K22148205			
C 3094	CHIP CAP.	0.1uF	25V	B	GRM40B104K25PT	K22140811			
C 3095	CHIP CAP.	0.001uF	25V	B	TKK105B102K-F	K22148820			
C 3096	CHIP CAP.	0.01uF	18V	B	GRK105B103K-F	K22128802			
C 3097	CHIP CAP.	0.01uF	50V	B	GRM40B103K50PT	K22170817			
C 3098	CHIP CAP.	150pF	18V	CH	TKK105CH1500-F	K22128204			
C 3099	CHIP CAP.	1pF	25V	OK	TKK105CK0100-F	K22148205			
C 3100	CHIP CAP.	22pF	25V	CH	TKK105CH2200-F	K22148222			

REF.	DESCRIPTION	VALUE	PKT	TOL.	PCOR'S DESIGN	WASSED P/N	WRES.	LOC.	LAY. ADD.
C 3101	CHIP CAP.	0.001uF	25V	A	TYX105B1C2X-F	K2214882C			
C 3102	TANTALUM CHIP CAP.	47uF	4V		TEMSV320647GM-85	K7800C02C			
C 3103	CHIP CAP.	150pF	16V	CH	EMX105CH151J-F	K221288204			
C 3104	CHIP CAP.	0.001uF	50V	B	GRM33B102M50PT	K22174809			
C 3105	CHIP CAP.	0.1uF	25V	B	GRM44B104K25PT	K22140811			
C 3106	CHIP CAP.	45pF	25V	CH	TYX105CHC40C-F	K22148208			
C 3107	CHIP CAP.	0.001uF	25V	B	TYX105B1C2X-F	K2214882C			
C 3109	CHIP CAP.	0.001uF	25V	B	TYX105B1C2X-F	K2214882C			
C 3110	CHIP CAP.	33pF	25V	CH	TYX105CH330J-F	K22148228			
C 3111	CHIP CAP.	0.001uF	25V	B	TYX105B1C2X-F	K2214882C			
C 3112	CHIP CAP.	25pF	25V	CH	TYX105CHC25C-F	K22148208			
C 3113	CHIP CAP.	0.01uF	16V	B	EMX105B1C3X-F	K221288202			
C 3114	CHIP CAP.	0.01uF	16V	B	EMX105B1C3X-F	K221288202			
C 3115	CHIP CAP.	33pF	25V	CH	TYX105CH330J-F	K22148228			
C 3117	CHIP CAP.	22pF	25V	CH	TYX105CH220J-F	K22148222			
C 3118	CHIP CAP.	0.001uF	25V	B	GRM33B102M25PT	K22140811			
C 3119	CHIP CAP.	0.001uF	25V	B	TYX105B1C2X-F	K2214882C			
C 3121	CHIP CAP.	0.001uF	50V	B	GRM33B102M50PT	K22174809			
C 3123	CHIP CAP.	0.001uF	25V	B	TYX105B1C2X-F	K2214882C			
C 3124	CHIP CAP.	8pF	25V	CH	TYX105CHC80C-F	K22148212			
C 3125	CHIP CAP.	22pF	25V	CH	TYX105CH220J-F	K22148222			
C 3126	CHIP CAP.	5pF	25V	CH	TYX105CHC50C-F	K22148206			
C 3127	CHIP CAP.	5pF	25V	CH	TYX105CHC50C-F	K22148206			
C 3128	CHIP CAP.	4pF	25V	CH	TYX105CHC40C-F	K22148208			
C 3129	CHIP CAP.	8pF	25V	CH	TYX105CHC80C-F	K22148212			
C 3130	CHIP CAP.	6pF	25V	CH	TYX105CHC60C-F	K22148210			
C 3132	CHIP CAP.	0.001uF	50V	B	GRM33B102M50PT	K22174809			
C 3133	CHIP CAP.	0.001uF	25V	B	GRM33B102M25PT	K22140811			
C 3134	CHIP CAP.	0.001uF	16V	B	EMX105B1C3X-F	K221288202			
C 3135	CHIP CAP.	0.001uF	25V	B	TYX105B1C2X-F	K2214882C			
C 3136	CHIP CAP.	0.001uF	16V	B	EMX105B1C3X-F	K221288202			
C 3137	TANTALUM CHIP CAP.	10uF	5.5V		TEMSV320610GM-82	K7800C027			
C 3138	CHIP CAP.	0.01uF	16V	B	EMX105B1C3X-F	K221288202			
C 3139	CHIP CAP.	47uF	16V		TEMSV320647GM-82	K7800C027			
C 3141	CHIP CAP.	0.001uF	25V	B	TYX105B1C2X-F	K2214882C			
C 3142	CHIP CAP.	0.001uF	25V	B	TYX105B1C2X-F	K2214882C			
C 3143	CHIP CAP.	0.001uF	25V	B	TYX105B1C2X-F	K2214882C			
C 3144	CHIP CAP.	0.001uF	25V	B	TYX105B1C2X-F	K2214882C			
C 3145	CHIP CAP.	0.001uF	25V	B	TYX105B1C2X-F	K2214882C			
C 3146	CHIP CAP.	0.001uF	25V	B	TYX105B1C2X-F	K2214882C			
C 3147	CHIP CAP.	0.001uF	25V	B	TYX105B1C2X-F	K2214882C			
C 3148	CHIP CAP.	0.001uF	16V	B	EMX105B1C3X-F	K221288202			
C 3149	CHIP CAP.	0.001uF	16V	B	EMX105B1C3X-F	K221288202			
C 3152	CHIP CAP.	0.001uF	25V	B	TYX105B1C2X-F	K2214882C			
C 3155	CHIP CAP.	0.001uF	50V	B	GRM33B102M50PT	K22174809			
C 3156	CHIP CAP.	0.001uF	50V	B	GRM33B102M50PT	K22174809			
C 3157	CHIP CAP.	0.001uF	50V	B	GRM33B102M50PT	K22174809			
C 3158	CHIP CAP.	0.001uF	25V	B	TYX105B1C2X-F	K2214882C			
C 3159	CHIP CAP.	0.001uF	50V	B	GRM33B102M50PT	K22174809			

430-MOTHER Unit

REF.	DESCRIPTION	VALUE	WV	TOL.	PCOR'S DESIG	FAESSE P/N	VSNS.	LOC.	LAY	AGE
C 3150	CHIP CAP.	0.001uF	25V	3	TKK1050102X-P	K22148820				
C 3151	CHIP CAP.	0.001uF	25V	3	TKK1050102X-P	K22148820				
C 3152	CHIP CAP.	0.001uF	25V	3	TKK1050102X-P	K22148820				
C 3153	CHIP CAP.	0.001uF	25V	3	TKK1050102X-P	K22148820				
C 3154	CHIP CAP.	0.001uF	25V	3	TKK1050102X-P	K22148820				
C 3155	CHIP CAP.	0.5pF	25V	OK	TKK1050KCR3C-P	K22148820				
C 3156	CHIP CAP.	0.001uF	25V	3	TKK1050102X-P	K22148820				
C 3157	CHIP CAP.	0.001uF	25V	3	TKK1050102X-P	K22148820				
C 3158	CHIP CAP.	0.001uF	25V	3	TKK1050102X-P	K22148820				
C 3159	CHIP CAP.	0.1uF	25V	3	GM403104M25PT	K22140811				
C 3170	TANTALUM CHIP CAP.	10uF	5.0V		TEMSVAC0103M-5R	K75090027				
C 3171	CHIP CAP.	0.001uF	25V	3	TKK1050102X-P	K22148820				
C 3172	TANTALUM CHIP CAP.	1uF	10V		TS9VSP1A103M-5R	K75100032				
CC3001	CERAMIC DISC				CFHM45507	E7900910				
CF3001	CERAMIC FILTER				CFHM4550F	E3900305				
D 3001	DIODE				1SS321 TE853	G2070073				
D 3002	DIODE				1SS321 TE853	G2070076				
D 3003	DIODE				RLS135 TE-11	G2070128				
D 3004	DIODE				RDS.6N31-T13	G2070352				
D 3005	DIODE				44111 (C-X)	G2070338				
D 3006	DIODE				RLS135 TE-11	G2070128				
D 3007	DIODE				HSU277	G2070118				
D 3008	DIODE				DAN222 TL	G2070174				
D 3009	DIODE				44721 (TX)	G2070258				
D 3010	DIODE				DAN222 TL	G2070174				
D 3011	DIODE				HSU277	G2070118				
D 3012	DIODE				DAN222 TL	G2070174				
D 3013	DIODE				DAN222 TL	G2070174				
D 3014	DIODE				1SS302 TE85R	G2070368				
D 3015	DIODE				1SS302 TE85R	G2070368				
D 3016	DIODE				CA221 TL	G2070178				
D 3017	DIODE				1SS205-T1	G2050009				
D 3018	DIODE				1T352 T8	G2070102				
D 3019	DIODE				1T352 T8	G2070102				
D 3020	DIODE				1T352 T8	G2070102				
D 3021	DIODE				1T352 T8	G2070102				
D 3022	DIODE				1T352 T8	G2070102				
D 3023	DIODE				1T352 T8	G2070102				
D 3024	DIODE				1T352 T8	G2070102				
D 3025	DIODE				1T352 T8	G2070102				
D 3026	DIODE				HSU277	G2070118				
J 3007	CONNECTOR				9120S C63	P1090526				
J 3008	CONNECTOR				22PS-L2C	PC091007				
L 3001	2. BFC	0.022uF			FK2135 220K-1	L1890361				

R.F.F.	DESCRIPTION	VALUE	WV	TOL.	PCOR'S DESIGN	WASCO P/N	WES.	LOC. 14" 404
L 3002	R. BFC	0.0111			IK2125 10K Ω -T	L1690377		
L 3003	COIL				2.572.000.50K Ω E	L0021799A		
L 3004	COIL				2.572.000.50K Ω E	L0021799A		
L 3005	COIL				2.572.000.50K Ω E	L0021799A		
L 3006	R. BFC	240 Ω			11032T-2210	L1690381		
L 3007	R. BFC	0.2211			IK2125 522K-T	L1690371		
L 3008	COIL				2.572.000.50K Ω E	L0021799A		
L 3009	COIL				2.572.000.50K Ω E	L0021799A		
L 3010	COIL				2.572.000.50K Ω E	L0021799A		
L 3011	R. BFC	0.01211			IK2125 12K Ω T	L1690375		
L 3012	COIL				2.572.000.50K Ω E	L0021799A		
L 3013	COIL				2.572.000.50K Ω E	L0021799A		
L 3014	R. BFC	0.06811			IK2125 68K Ω T	L1690387		
L 3015	R. BFC	0.06811			1K0015TC68K	L1690381		
L 3016	R. BFC	0.06811			1K0015TC68K	L1690381		
L 3017	R. BFC	120 Ω			FLC321-1210	L1690228		
L 3018	R. BFC	0.5611			1K0015TC56K	L1690116		
L 3019	R. BFC	0.5611			IK2125 35K Ω -T	L1690016		
L 3020	R. BFC	0.04211			IK2125 32K Ω -T	L1690081		
L 3021	R. BFC	0.01511			IK2125 15K Ω -T	L1690079		
L 3022	R. BFC	0.3311			IK2125 33K Ω T	L1690013		
L 3023	R. BFC	0.2211			IK2125 32K Ω -T	L1690011		
L 3024	R. BFC	0.5611			IK2125 35K Ω -T	L1690016		
L 3025	COIL				1.5T1.800.405W R	L0022253		
L 3026	COIL				1.5T1.800.405W R	L0022253		
L 3027	COIL				1.5T1.800.405W R	L0022253		
L 3028	COIL				1.5T1.800.405W R	L0022253		
L 3029	COIL				1.5T1.800.405W R	L0022253		
L 3030	R. BFC	0.01211			IK2125 12K Ω T	L1690375		
Q 3001	TRANSISTOR				3SC4537 TL	03345377		D-3
Q 3002	IC				M67700KA-21	01091938		A-2
Q 3003	TRANSISTOR				2SC4243 T383R	02342457		C-3
Q 3004	TRANSISTOR				2SC1243E TL	03070109		C-2
Q 3005	TRANSISTOR				2SA1588Y T0853	00115887Y		D-2
Q 3006	TRANSISTOR				2SD1132 T100 Q	00211327Q		A-2
Q 3007	TRANSISTOR				2CA1243E TL	03070113		C-2
Q 3008	TRANSISTOR				2SC4814 TL A	03346178A		D-2
Q 3009	IC				727925	01091710		C-2
Q 3010	TRANSISTOR				XP1501 (CX)	03070143		D-2
Q 3011	TRANSISTOR				XP1401 (CX)	03070142		D-3
Q 3012	TRANSISTOR				DT0124E3 TL	03070109		D-2
Q 3013	TRANSISTOR				2SC4228 12K 124	33342287C		A-1
Q 3014	TRANSISTOR				2SC42153 T383R	33342157Y		A-1
Q 3015	FB				2SK5800R T383R	03805800R		C-1
Q 3016	TRANSISTOR				2KB10N 1N	03070108		C-2
Q 3017	TRANSISTOR				XP4413 (TX)	03070140		D-2
Q 3018	IC				3H53H501A-71	01091503		A-3
Q 3019	TRANSISTOR				2CA1243E TL	03070116		D-1
Q 3020	TRANSISTOR				2SC1243E TL	03070108		C-2

430-MOTILER Unit

REF.	DESCRIPTION	VALUE	WV	TOL.	PCB'S DESIG	YACSL P/N	VRMS.	LOC.	LAY ACR
Q 3021	IC				TA7580P P-485P	31091593			D-3
Q 3022	TRANSISTOR				2N710N TK	33070103			D-2
Q 3023	TRANSISTOR				2C01243E TL	33070109			D-1
Q 3024	IC				TP80876-51	31091323			A-2
Q 3025	IC				TC78007 TE85K	31091442			B-2
Q 3026	TRANSISTOR				2N610N TA	33070105			C-2
Q 3027	TRANSISTOR				2A1438K TL	33070093			D-3
Q 3028	TRANSISTOR				2C01243E TL	33070109			D-2
Q 3029	IC				TA11230M	31081653			A-3
Q 3030	TRANSISTOR				2SD1132 T10C Q	332113279			B-3
Q 3033	TRANSISTOR				2P1301-(T2)	33070103			B-3
Q 3034	TRANSISTOR				2SC4226Y TE85A	33342157Y			C-1
Q 3035	TRANSISTOR				2SC4226-T2B R24	33342267D			C-1
Q 3036	TRANSISTOR				2SC4617 TL 2	33346178E			C-3
Q 3037	IC				MC33924MK	31081654			C-1
Q 3038	TRANSISTOR				2SC4226-T2B R2Y	33342267D			C-1
Q 3039	TRANSISTOR				2SC4226-T2B R24	33342267D			B-1
Q 3040	TRANSISTOR				2SC4617 TL 2	33346178E			C-3
Q 3041	IC				TC43685D TE12L	31081676			C-3
Q 3042	TRANSISTOR				2C01243E TL	33070109			D-2
R 3001	CHIP RES.	10K	1/16W	0.5%	R20510P-103-D	J24189143			
R 3002	CHIP RES.	4.7K	1/16W	0.5%	R20510P-472-D	J24189135			
R 3003	CHIP RES.	0.8K	1/16W	0.5%	R20510P-382-D	J24189139			
R 3004	CHIP RES.	15K	1/16W	0.5%	R20510P-153-D	J24189147			
R 3005	CHIP RES.	4.7K	1/16W	0.5%	R20510P-472-D	J24189135			
R 3006	CHIP RES.	22K	1/16W	0.5%	R20510P-223-D	J24189151			
R 3007	CHIP RES.	10K	1/16W	0.5%	R20510P-103-D	J24189143			
R 3008	CHIP RES.	4.7K	1/16W	0.5%	R20510P-472-D	J24189135			
R 3009	CHIP RES.	330	1/16W	0.5%	R40510P-331-D	J24189107			
R 3010	CHIP RES.	10	1/16W	5%	RK01/16S 100JTE	J24189001			
R 3011	CHIP RES.	470	1/16W	0.5%	R20510P-471-D	J24189111			
R 3012	CHIP RES.	13	1/16W	0.5%	R20510P-132-D	J24189119			
R 3013	CHIP RES.	470	1/16W	0.5%	R20510P-471-D	J24189111			
R 3014	CHIP RES.	10	1/16W	5%	RK01/16S 100JTE	J24189001			
R 3015	CHIP RES.	10	1/16W	5%	RK01/16S 100JTE	J24189001			
R 3016	CHIP RES.	470	1/16W	0.5%	R20510P-471-D	J24189111			
R 3017	CHIP RES.	47	1/16W	5%	RK01/16S 470JTE	J24189009			
R 3018	CHIP RES.	100K	1/16W	0.5%	R20510P-104-D	J24189167			
R 3019	CHIP RES.	56	1/10W	5%	EP01/16S 560J	J24205560			
R 3020	CHIP RES.	2.2K	1/16W	0.5%	R20510P-222-D	J24189127			
R 3021	CHIP RES.	1K	1/16W	0.5%	R20510P-102-D	J24189113			
R 3022	CHIP RES.	1K	1/16W	0.5%	R20510P-102-D	J24189113			
R 3023	CHIP RES.	10K	1/16W	0.5%	R20510P-103-D	J24189143			
R 3024	CHIP RES.	2.2K	1/16W	0.5%	R20510P-222-D	J24189127			
R 3025	CHIP RES.	220K	1/16W	5%	RK01/16S 220JTE	J24189053			
R 3027	CHIP RES.	1K	1/16W	0.5%	R20510P-102-D	J24189113			
R 3028	CHIP RES.	10K	1/16W	0.5%	R20510P-103-D	J24189143			
R 3029	CHIP RES.	33K	1/16W	0.5%	R20510P-333-D	J24189155			

REF.	DESCRIPTION	VALUE	WV	10%	4-30'S ERSGG	FASSC P/N	VERSL	LOT. LAY A.M.
R 3000	CHIP RES.	1K	1/16W	0.5%	RRC51CP-102-D	J24189119		
R 3001	CHIP RES.	1K	1/16W	0.5%	RRC51CP-102-D	J24189119		
R 3002	C- P RES.	2.2K	1/16W	0.5%	RRC51CP-222-D	J24189127		
R 3003	CHIP RES.	1K	1/16W	0.5%	RRC51CP-102-D	J24189119		
R 3004	CHIP RES.	47K	1/16W	0.5%	RRC51CR-473-D	J24189159		
R 3005	C- P RES.	22K	1/16W	0.5%	RRC51CR-222-D	J24189157		
R 3006	CHIP RES.	10K	1/16W	0.5%	RRC51CP-103-D	J24189143		
R 3007	CHIP RES.	10K	1/16W	0.5%	RRC51CP-103-D	J24189143		
R 3008	CHIP RES.	10K	1/16W	0.5%	RRC51CP-103-D	J24189143		
R 3009	C- P RES.	47K	1/16W	5%	RMCL/1SS 470JTH	J24189109		
R 3010	CHIP RES.	5.5K	1/16W	0.5%	RRC51CP-652-D	J24189139		
R 3011	CHIP RES.	10K	1/16W	0.5%	RRC51CP-103-D	J24189143		
R 3012	CHIP RES.	10K	1/16W	0.5%	RRC51CP-103-D	J24189143		
R 3013	C- P RES.	470	1/16W	0.5%	RRC51CP-471-D	J24189111		
R 3014	CHIP RES.	33K	1/16W	0.5%	RRC51CR-333-D	J24189165		
R 3015	CHIP RES.	10K	1/16W	0.5%	RRC51CP-103-D	J24189143		
R 3016	CHIP RES.	1K	1/16W	0.5%	RRC51CP-102-D	J24189119		
R 3017	CHIP RES.	100K	1/16W	0.5%	RRC51CR-101-D	J24189167		
R 3018	CHIP RES.	3.3K	1/16W	0.5%	RRC51CP-332-D	J24189133		
R 3019	CHIP RES.	4.7K	1/16W	0.5%	RRC51CP-472-D	J24189135		
R 3020	CHIP RES.	100K	1/16W	0.5%	RRC51CR-101-D	J24189167		
R 3021	CHIP RES.	10K	1/16W	0.5%	RRC51CP-103-D	J24189143		
R 3022	CHIP R-S.	10	1/16W	5%	RMCL/1SS 100JTH	J24189107		
R 3023	CHIP R-S.	100K	1/16W	0.5%	RRC51CP-101-D	J24189167		
R 3024	CHIP RES.	300	1/16W	0.5%	RRC51CP-331-D	J24189107		
R 3025	CHIP RES.	47K	1/16W	0.5%	RRC51CR-473-D	J24189155		
R 3026	CHIP RES.	33K	1/16W	0.5%	RRC51CR-333-D	J24189155		
R 3027	CHIP R-S.	2.2K	1/16W	0.5%	RRC51CP-222-D	J24189127		
R 3028	CHIP RES.	680K	1/16W	5%	RMCL/1SS 681JTH	J24189109		
R 3029	CHIP RES.	1K	1/16W	0.5%	RRC51CP-102-D	J24189119		
R 3030	CHIP RES.	15K	1/16W	0.5%	RRC51CR-153-D	J24189149		
R 3031	CHIP RES.	2.2K	1/16W	0.5%	RRC51CP-222-D	J24189127		
R 3032	CHIP RES.	320K	1/16W	5%	RMCL/1SS 324JTH	J24189163		
R 3033	CHIP RES.	100K	1/16W	0.5%	RRC51CR-101-D	J24189167		
R 3034	CHIP RES.	2.2K	1/16W	0.5%	RRC51CP-222-D	J24189127		
R 3035	CHIP RES.	2.2K	1/16W	0.5%	RRC51CP-222-D	J24189127		
R 3036	CHIP RES.	100K	1/16W	0.5%	RRC51CR-101-D	J24189167		
R 3037	CHIP RES.	3.3K	1/16W	0.5%	RRC51CP-332-D	J24189133		
R 3038	CHIP RES.	1.5K	1/16W	0.5%	RRC51CP-152-D	J24189123		
R 3039	CHIP RES.	10K	1/16W	0.5%	RRC51CP-103-D	J24189143		
R 3040	CHIP RES.	47K	1/16W	0.5%	RRC51CR-473-D	J24189159		
R 3041	CHIP RES.	100K	1/16W	0.5%	RRC51CR-101-D	J24189167		
R 3042	C- P R-S.	470	1/16W	0.5%	RRC51CP-471-D	J24189111		
R 3043	CHIP RES.	100K	1/16W	0.5%	RRC51CR-101-D	J24189167		
R 3044	CHIP RES.	100K	1/16W	0.5%	RRC51CR-101-D	J24189167		
R 3045	CHIP R-S.	470	1/16W	0.5%	RRC51CP-471-D	J24189111		
R 3046	CHIP RES.	100K	1/16W	0.5%	RRC51CR-101-D	J24189167		
R 3047	CHIP R-S.	470	1/16W	0.5%	RRC51CP-471-D	J24189111		
R 3048	CHIP RES.	1.5K	1/16W	0.5%	RRC51CP-152-D	J24189123		

430-MOTHER Unit

REF.	DESCRIPTION	VALUE	PKY	TOL.	MANUFACTURER'S DESG.	MANSC P/N	VERB.	LOC. LAY. ADJ.
R 3080	CHIP RES.	4.7K	1/16W	0.5%	BR06LCP-472-D	J24189135		
R 3081	CHIP RES.	33K	1/16W	0.5%	BR06LCP-332-D	J24189135		
R 3082	CHIP RES.	33K	1/16W	0.5%	BR06LCP-332-D	J24189135		
R 3083	CHIP RES.	10K	1/16W	0.5%	BR06LCP-102-D	J24189142		
R 3084	CHIP RES.	1.8K	1/16W	0.5%	BR06LCP-182-D	J24189125		
R 3085	CHIP RES.	470	1/16W	0.5%	BR06LCP-471-D	J24189111		
R 3086	CHIP RES.	0	1/16W		AK21/18S JPSH	J24189070		
R 3087	CHIP RES.	4.7K	1/16W	0.5%	R20510P-472-D	J24189135		
R 3088	CHIP RES.	1.8K	1/16W	0.5%	R20510P-182-D	J24189125		
R 3089	CHIP RES.	1K	1/16W	0.5%	R20510P-102-D	J24189119		
R 3090	CHIP RES.	33K	1/16W	0.5%	R20510P-332-D	J24189155		
R 3091	CHIP RES.	3.3K	1/16W	0.5%	R20510P-332-D	J24189131		
R 3092	CHIP RES.	47K	1/16W	0.5%	R20510P-472-D	J24189159		
R 3093	CHIP RES.	27	1/16W	5%	RMCL/13S 270JTE	J24189008		
R 3100	CHIP RES.	470K	1/16W	5%	RMCL/13S 474JTE	J24189057		
R 3101	CHIP RES.	3.3K	1/16W	0.5%	RRC51CP-232-D	J24189131		
C30C01	TELETYPE CAP.	20nF			WCP 1804CK12	K910C0188		
C30C02	CHIP TELETYPE	6pF			CT938-064-WT-1	K910C0206		
C30C03	CHIP TELETYPE	6pF			CT938-064-WT-1	K910C0206		
C30C04	CHIP TELETYPE	6pF			CT938-064-WT-1	K910C0206		
C30C05	CHIP TELETYPE	6pF			CT208-064-WT-1	K910C0206		
TH3C01	THERMISTOR				157-202-55C095P	39C90C45		
VR3C01	POT.	10K			PH03AVAL2X01A	J50755103		
X 30C01	XTAL	12.800000MHz				H3103C91		
X 30C02	XTAL	38.079MHz				H3103C75		
XP3C01	XTAL				0555-13401	H1102252		
	HOUSING PLATE (PPL)					30150700		

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Parts List

REF.	DESCRIPTION	VALUE	WV	COL.	MFG'S PART	YAESU P/N	VSRS.	QTY.	DAY	MR.
*** 144-VCO UNIT ***										
	PCB With Components					047828037				
	Printed Circuit Board					KS454701				
C 4001	CHIP CAP.	0.001 μ F	25V	D	TKK1C53102K-F	X22148820				
C 4002	CHIP CAP.	0.001 μ F	25V	D	TKK1C53102K-F	X22148820				
C 4003	CHIP CAP.	0.001 μ F	25V	D	TKK1C53102K-F	X22148820				
C 4004	CHIP CAP.	0.001 μ F	25V	B	TKK1C53102K-F	X22148820				
C 4005	CHIP CAP.	22pF	25V	C1	TKK1C50H220J-F	X22148222				
C 4006	CHIP CAP.	5pF	25V	CJ	TKK1C50J0500-F	X22148407				
C 4007	CHIP CAP.	0.5pF	25V	CA	TKK1C50C0150-F	X22148404				
C 4008	CHIP CAP.	22pF	25V	C1	TKK1C50H220J-F	X22148222				
C 4009	CHIP CAP.	0.001 μ F	16V	F	EMK1C5P4732-F	X22129002				
C 4010	CHIP CAP.	2pF	25V	C3	TKK1C50K0200-F	X22148205				
C 4012	CHIP CAP.	0.001 μ F	16V	F	EMK1C5P4732-F	X22129002				
C 4013	CHIP CAP.	10pF	25V	C1	TKK1C50H10J-F	X22148414				
C 4014	CHIP CAP.	15pF	25V	C1	TKK1C50H150J-F	X22148218				
C 4015	CHIP CAP.	270pF	25V	B	TKK1C53271K-F	X22148813				
C 4016	CHIP CAP.	3pF	25V	C1	TKK1C50J0300-F	X22148207				
C 4017	CHIP CAP.	0.047 μ F	16V	F	EMK1C5P4732-F	X22129002				
C 4018	CHIP CAP.	0.047 μ F	16V	F	EMK1C5P4732-F	X22129002				
C 4019	CHIP CAP.	470pF	25V	B	TKK1C53471K-F	X22148815				
C 4020	CHIP CAP.	0.001 μ F	25V	B	TKK1C53102K-F	X22148820				
C 4021	CHIP CAP.	0.001 μ F	25V	B	TKK1C53102K-F	X22148820				
D 4001	DIODE				60L350-13	02070308				
D 4002	DIODE				6SU477	02070118				
D 4004	DIODE				6SU277	02070118				
J 4001	CONNECTOR				99138 1 3PC "	PC091080				
L 4001	R.F. COIL	0.1 μ H			LR2125 R1CK-F	L1590307				
L 4002	R.F. COIL	0.1 μ H			LR2125 R1CK-F	L1590307				
L 4003	COIL				L5231110C501	00022337				
L 4004	R.F. COIL	4.7 μ H			LR2125 457K-F	L1590327				
L 4005	COIL				L5231107C501	00022338				
L 4006	R.F. COIL	4.7 μ H			LR2125 457K-F	L1590327				
Q 4001	TRANSISTOR				2SC4226-T23 R24	033422670				
Q 4002	TRANSISTOR				2SC4226-T23 R24	033422670				
Q 4003	TRANSISTOR				2SC4226-T23 R24	033422670				
Q 4004	TRANSISTOR				DT01432B TL	03070102				
R 4001	CHIP RES.	68	1/16W 5%		R401/168 880JH	J24189011				
R 4002	CHIP RES.	68	1/16W 5%		R401/168 880JH	J24189011				
R 4003	CHIP RES.	22K	1/16W 0.5%		R5C51CP-225-D	J24189051				
R 4004	CHIP RES.	390	1/16W 0.5%		R5C51CP-391-D	J24189105				

144-VCO Unit

REF.	DESCRIPTION	VALUE	WF	TOL.	MFGR'S CODE	YAESU P/N	QWTS.	LOC.	LAY	ADZ
R 4005	CHIP RES.	1K	1/16W	0.5%	RC0505F-102-D	J24189119				
R 4006	CHIP RES.	3.3K	1/16W	0.5%	RC0505F-332-D	J24189131				
R 4007	CHIP RES.	39K	1/16W	0.5%	RC0505R-393-D	J24189137				
R 4008	CHIP RES.	39K	1/16W	0.5%	RC0505R-393-D	J24189159				
R 4009	CHIP RES.	10K	1/16W	0.5%	RC0510P-103-D	J24189145				
R 4010	CHIP RES.	10K	1/16W	0.5%	RC0510P-103-D	J24189143				
R 4011	CHIP RES.	220	1/16W	0.5%	RC0510P-221-D	J24189103				
R 4013	CHIP RES.	100K	1/16W	0.5%	RC0510E-104-D	J24189167				
SHIELD CASE (VCO)						SC-50240				

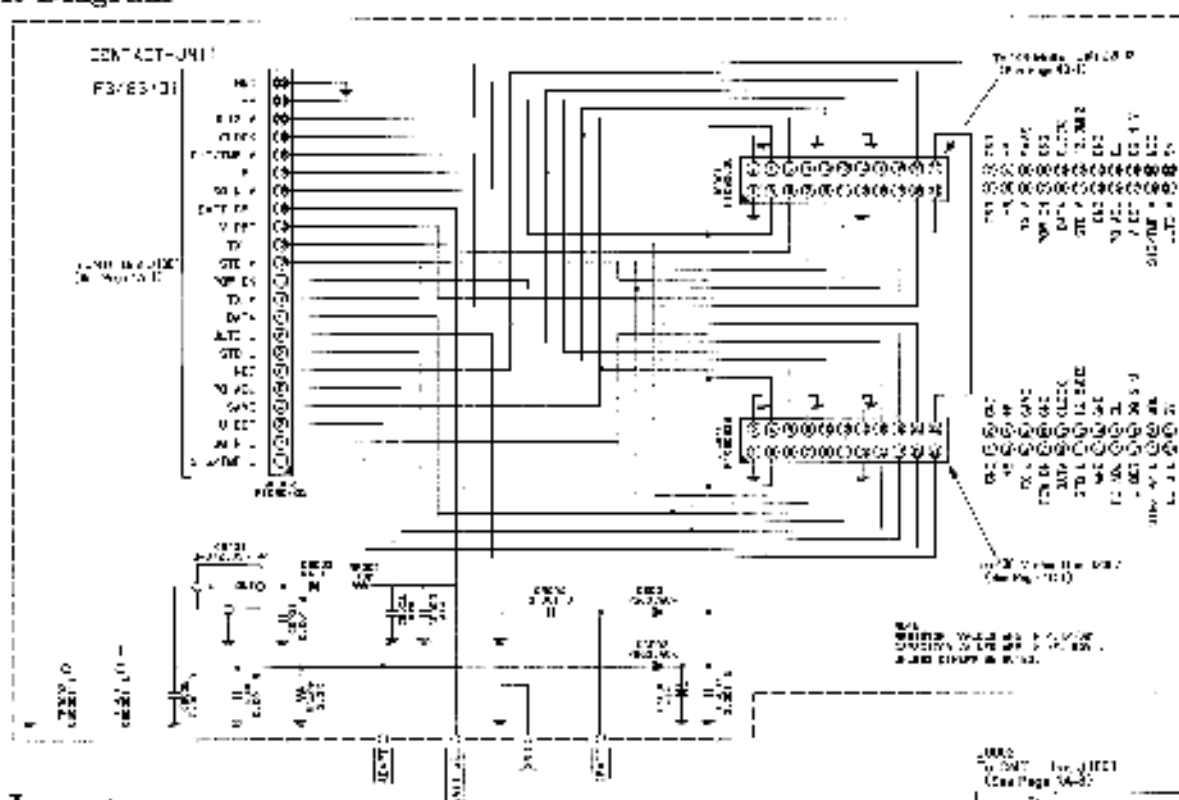
Parts List

REF.	DESIG. PT. OR	VALUE	W	TOL.	FOUR'S DSG13	WAGO P/N	WCS.	LOT.	LAY	AD2
*** 430-VCO UNIT ***										
PCB Mfg. Components						CA1225001				
Printed Circuit Board						73-84102				
C 5001	CHIP CAP.	0.001uF	25V	5	TKX105B102X-F	K22148820				
C 5002	CHIP CAP.	0.001uF	25V	5	TKX105B102X-F	K22148820				
C 5003	CHIP CAP.	0.001uF	25V	5	TKX105B102X-F	K22148820				
C 5004	CHIP CAP.	0.001uF	25V	5	TKX105B102X-F	K22148820				
C 5005	CHIP CAP.	5uF	25V	CH	TKX105C-0500-F	K22148210				
C 5006	CHIP CAP.	1uF	25V	CH	TKX105C30100-F	K22148206				
C 5007	CHIP CAP.	0.5uF	25V	CH	TKX105C40050-F	K22148204				
C 5008	CHIP CAP.	12pF	25V	CH	TKX105C01200-F	K22148216				
C 5009	CHIP CAP.	0.047uF	16V	F	EMK105F4732-F	K22129002				
C 5010	CHIP CAP.	25pF	25V	CH	TKX105C30200-F	K22148206				
C 5011	CHIP CAP.	1pF	25V	CH	TKX105C30100-F	K22148206				
C 5012	CHIP CAP.	0.047uF	16V	F	EMK105F4732-F	K22129002				
C 5013	CHIP CAP.	5uF	25V	CH	TKX105C0500-F	K22148208				
C 5014	CHIP CAP.	5uF	25V	CH	TKX105C-0500-F	K22148210				
C 5015	CHIP CAP.	39pF	25V	CH	TKX105C1390-F	K22148228				
C 5016	CHIP CAP.	2pF	25V	CH	TKX105C30050-F	K22148206				
C 5017	CHIP CAP.	0.047	16V	F	EMK105F4732-F	K22129002				
C 5018	CHIP CAP.	0.047uF	16V	F	EMK105F4732-F	K22129002				
C 5019	CHIP CAP.	100pF	25V	CH	TKX105C-101-F	K22148238				
C 5020	CHIP CAP.	0.001uF	25V	B	TKX105B102K-F	K22148520				
C 5021	CHIP CAP.	0.001uF	25V	B	TKX105B102K-F	K22148520				
C 5022	CHIP CAP.	15pF	25V	CH	TKX105C01500-F	K22148218				
C 5023	TANTALUM CHIP CAP.	1uF	10V		T6SVSP1A100M-83	K78100002				
D 5001	DIODE				HSU350-TR	G237C380				
D 5002	DIODE				HSU277	G247C118				
D 5004	DIODE				HSU277	G237C118				
J 5001	CONNECTOR				92-38 J-07C "	PC091030				
L 5001	M. LFO	0.056uH			LR2125 55NK-F	L1590380				
L 5002	M. LFO	0.056uH			LR2125 55NK-F	L1590380				
L 5003	COIL				LE2311040501	W022305				
L 5004	M. RFO	1.0uH			LR2125 150K-F	L1590319				
L 5005	M. RFO	0.0068uH			LR2125 338K-F	L1590375				
L 5006	M. RFO	1.0uH			LR2125 150K-F	L1590319				
Q 5001	TRANSISTOR				2SC5008-TR	G3350055				
Q 5002	TRANSISTOR				2SC5008-TR	G3350055				
Q 5003	TRANSISTOR				2SC5008-TR	G3350055				
Q 5004	TRANSISTOR				UTC43X-TR	33070102				
R 5001	CHIP RES.	100	1/16W	0.5%	R50510P-010	J36159095				

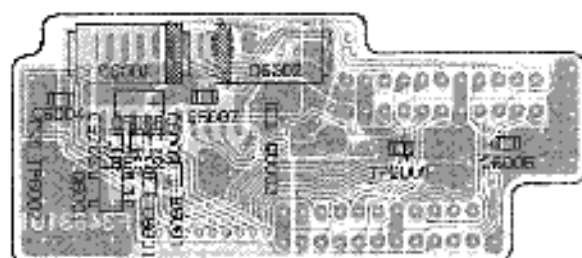
430-VCO Unit

REF.	DESCRIPTION	VALUE	WV	TOL.	KPCB'S DESIG	Y433, P/N	Q433.	LOT.	LAY	ACK
R 5002	CHIP RES.	100	1/16W	0.5%	3R05100-101-D	J24189095				
R 5003	CHIP RES.	22K	1/16W	0.5%	3R05100-223-D	J24189131				
R 5004	CHIP RES.	47	1/16W	5%	3R05100-470-TH	J24189009				
R 5005	CHIP RES.	13	1/16W	0.5%	3R05100-103-D	J24189119				
R 5006	CHIP RES.	2.2K	1/16W	0.5%	3R05100-223-D	J24189129				
R 5007	CHIP RES.	22K	1/16W	0.5%	3R05100-223-D	J24189151				
R 5008	CHIP RES.	22K	1/16W	0.5%	3R05100-223-D	J24189151				
R 5009	CHIP RES.	6.7K	1/16W	0.5%	3R05100-472-D	J24189133				
R 5010	CHIP RES.	10K	1/16W	0.5%	3R05100-103-D	J24189143				
R 5011	CHIP RES.	100	1/16W	0.5%	3R05100-101-D	J24189095				
R 5013	CHIP RES.	100K	1/16W	0.5%	3R05100-104-D	J24189187				
SHIELD CASE (VCO)						30140240				

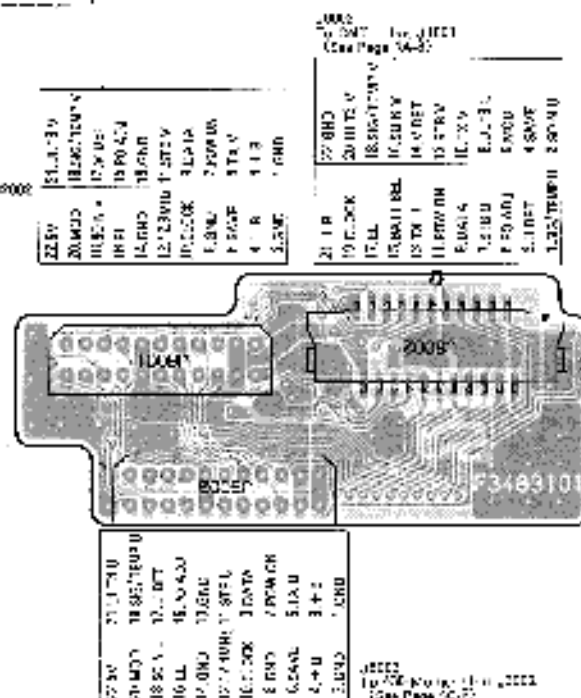
Circuit Diagram



Parts Layout

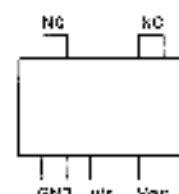


obverse view of component side



obverse view of connector side

Flat Ribbon Cable (P/N F3486000)

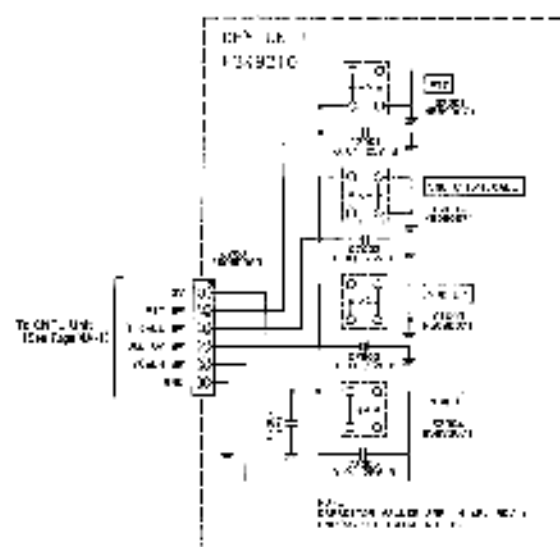


S 81230SG (QF)
(Q6001)

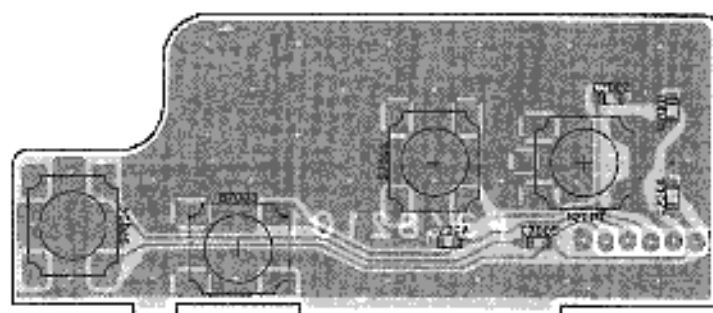
Parts List

REF.	DESCRIPTION	VALUE	SW	TOL.	MPOR'S DESIG	YAGSU P/S	RESS.	QTY.	LOT NO.
*** CONTACT UNIT ***									
	PCB With Components (w/ JPC Cable)					041200001			
	Printed Circuit Board					P3463001			
	JPC Cable					P3456000			
C 6001	CHIP CAP.	0.001uF	50V	B	32X39B102M50PT	K22174509			
C 6004	CHIP CAP.	0.001uF	50V	B	32X39B102M50PT	K22174509			
C 6005	CHIP CAP.	0.001uF	50V	B	32X39B102M50PT	K22174509			
C 6006	CHIP CAP.	0.001uF	50V	B	32X39B102M50PT	K22174509			
C 6007	CHIP CAP.	0.001uF	50V	B	32X39B102M50PT	K22174509			
D 6001	DIODE				N3003A04-TS16L3	32070074			
D 6002	DIODE				N3003A04-TS16L3	32070074			
D 6003	DIODE				KAL11-(TX)	62070038			
J 6001	CONNECTOR				223-J50	71090025			
J 6002	CONNECTOR				7E2412-PX03022F	71090045			
J 6003	CONNECTOR				223-J50	71090025			
Q 6001	IC				S 612-050 QH-T1	61091525			
R 6001	CHIP RES.	10K	1/16W	5%	RM01/16 103JATF	J24185103			
R 6002	CHIP RES.	2.2K	1/16W	5%	RM01/16 222JATF	J24185222			
TP6001	CHECK TERMINAL				82000000	Q5000113			
TP6002	CHECK TERMINAL				82000000	Q5000113			

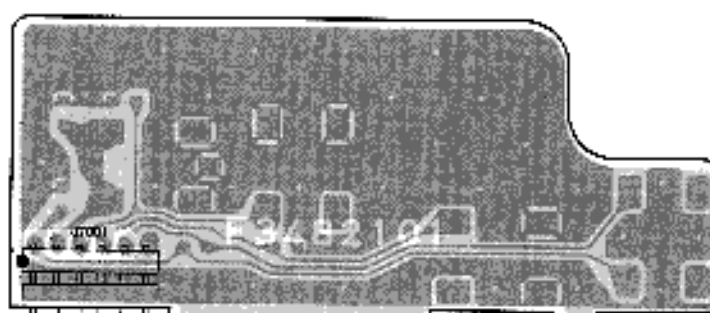
Circuit Diagram



Parts Layout



obverse view of component side



obverse view of connector side

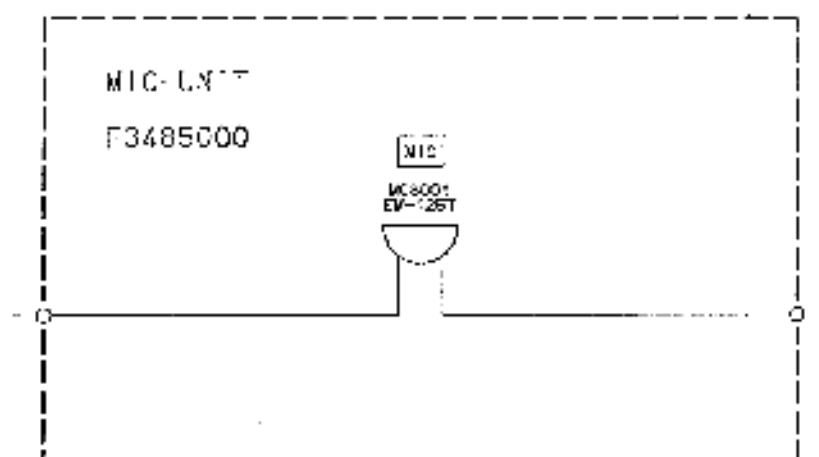
To CNT. Unit
(See Page 4A-3)

24
+115V
T CALL SW
T10 OP SW
POWER SW
GND

Parts List

REF.	DESCRIPTION	VALUE	WV	TOL.	MPER'S DESIG	YARSH P/N	YARSH.	LOC.	LAY	ADN
*** KEY UNIT ***										
	PCB With Components					CA1221001				
	Printed Circuit Board					F3482101				
C 7001	CHIP CAP.	0.01uF	25V	B	GEN390103M25P	K22144802				
C 7002	CHIP CAP.	0.01uF	25V	B	GEN390103M25P	K22144802				
C 7003	CHIP CAP.	0.01uF	25V	B	GEN390103M25P	K22144802				
C 7005	CHIP CAP.	0.01uF	25V	B	GEN390103M25P	K22144802				
J 7001	CONNECTOR				92306-1-062065-7	P009098C				
S 7001	TACT SWITCH				SOP-112HST	N6090071				
S 7002	TACT SWITCH				SOP-112HST	N6090071				
S 7003	TACT SWITCH				SOP-112HST	N6090071				
S 7004	TACT SWITCH				SOP-112HST	N6090071				

Circuit Diagram



Parts Layout



obverse view of microphone side



obverse view of PCB

Parts List

REF.	DESCRIPTION	VALUE	WV	TOL.	YAESU'S DESIG	YAESU P/N	VERS.	LOT.	LAY	ADR
*** MIC UNIT ***										
	PCB With Components					CA132300				
	Printed Circuit Board					F3485000				
KCS001	MIC ELEMENT				EM-125T	M3290025				